

# Micron's Memory solutions for the latest i.MX 8M Family

## NXP Connects Santa Clara

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# Abstract

## Micron's Memory solutions for the latest i.MX 8M Family

- NXP's latest i.MX 8M processors require the latest memories to keep them running efficiently. As a system designer, your memory choices can impact the performance, size, cost, power reliability and longevity of your end product.
- We will discuss the latest memories supported on the new i.MX 8M processor family. This includes DDR3, DDR4 and LPDDR4. We will show designers how they can prioritize performance, power or price to optimize their systems.
- We will also highlight a new MCP that includes LPDDR4 and eMMC in a single space saving package.
- This session will provide designers with some of the tools to create state-of-the-art i.MX 8M systems.

# Micron Automotive Memory Solutions



NOR

- Parallel
- Serial



DRAM

- SDR/DDR
- LPDDR/LPDDR



MCP



NAND

- SLC NAND



e-MMC/UFS



SSD



microSD



**NXP Micron®**  
**Compatibility Guides**

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# Micron® Memory Support for NXP® i.MX 8M Platforms

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| Micron Memory  |                | i.MX 8M Processor Memory                         |                      |                       |                         |                      |                      |                         |                     |                         |
|----------------|----------------|--|----------------------|-----------------------|-------------------------|----------------------|----------------------|-------------------------|---------------------|-------------------------|
|                |                | i.MX 8M Quad/Qual Lite<br>i.MX 8M Dual/Dual Lite |                      |                       | i.MX 8M Mini            |                      |                      | i.MX 8M Nano            |                     |                         |
| DRAM           | Type           | DDR3L  | DDR4                 | LPDDR4                | DDR3L                   | DDR4                 | LPDDR4               | DDR3L                   | DDR4                | LPDDR4                  |
|                | Family         | MT41K  | MT40A                | MT53                  | MT41K                   | MT40A                | MT53                 | MT41K                   | MT40A               | MT53                    |
|                | Density        | 1, 2, 4, 8Gb                                     | 4, 8, 16Gb           | 4, 8, 16, 24, 32Gb    | 1, 2, 4, 8Gb            | 4, 8, 16Gb           | 4, 8, 16, 24, 32Gb   | 1, 2, 4, 8Gb            | 4, 8, 16Gb          | 2, 4, 8Gb               |
|                | Configuration  | x16  | x16                  | x32                   | x16                     | x16                  | x32                  | x16                     | x16                 | x16                     |
|                | Package        | 96-ball TFBGA                                    | 96-ball TFBGA        | 200-ball FBGA         | 96-ball TFBGA           | 96-ball TFBGA        | 200-ball FBGA        | 96-ball TFBGA           | 96-ball TFBGA       | 200-ball FBGA           |
|                | Validated PN   |  | MT40A512M-16LY-075:E | MT53D1024M-32D4DT-053 | MT41K-256M16TW-107      | MT40A512M-16LY-075:E | MT53D512M-32D2DS-053 |                         |                     |                         |
|                | Recommended PN | MT41K256M-16TW-093:P                             |                      |                       | MT41K-256M16TW-093:P    |                      |                      | MT41K-256M16TW-093:P    | MT40A1G-16PC-062E:B | MT53D512M-16D1DS-046 WT |
| Qty/Board      | 2              | 2  | 1                    | 2                     | 2                       | 1                    | 2                    | 2                       | 1                   |                         |
| NAND/<br>e.MMC | Type           | e.MMC (5.0)                                      |                      |                       | e.MMC (5.0)             |                      |                      | e.MMC (5.0)             |                     |                         |
|                | Family         | MTFC   |                      |                       | MTFC                    |                      |                      | MTFC                    |                     |                         |
|                | Density        | 16GB   |                      |                       | 16GB                    |                      |                      | 16GB                    |                     |                         |
|                | Package        | 153-ball VFBGA                                   |                      |                       | 153-ball VFBGA          |                      |                      | 153-ball VFBGA          |                     |                         |
|                | Validated PN   | MTFC16GAKAECN-2M WT                              |                      |                       |                         |                      |                      |                         |                     |                         |
|                | Recommended PN |  |                      |                       | MTFC16GAKAECN-2M WT     |                      |                      | MTFC16GAKAECN-2M WT     |                     |                         |
| NOR            | Type           | Quad SPI   |                      |                       | Quad SPI                |                      |                      | Quad SPI                |                     |                         |
|                | Family         | MT25Q  |                      |                       | MT25Q                   |                      |                      | MT25Q                   |                     |                         |
|                | Density        | 256Mb  |                      |                       | 256Mb                   |                      |                      | 256Mb                   |                     |                         |
|                | Package        | 24-ball BGA (8mm x 6mm)                          |                      |                       | 24-ball BGA (8mm x 6mm) |                      |                      | 24-ball BGA (8mm x 6mm) |                     |                         |
|                | Validated PN   | MT25Q256ABA1EW9-0SIT                             |                      |                       |                         |                      |                      |                         |                     |                         |
|                | Recommended PN |  |                      |                       | MT25Q256ABA1EW9-0SIT    |                      |                      | MT25Q256ABA1EW9-0SIT    |                     |                         |

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| Micron Memory |               | i.MX 8 Processor Memory                              |  |   |
|---------------|---------------|--|--|---|
|               |               | i.MX 8 Quad Max,<br>i.MX 8 Quad Plus,<br>i.MX 8 Quad |  | i.MX 8 Quad X Plus,<br>i.MX 8 Dual X Plus,<br>i.MX 8 Dual X |
| DRAM          | Type          | LPDDR4   | LPDDR4                                       | DDR3  |
|               | Family        | MT53B  | MT53B  | MT41K   |
|               | Density       | 32Gb   | 32Gb   | 4Gb   |
|               | Configuration | 512 Meg x 32   | 512 Meg x 32                                 | 256 Meg x 16  |
|               | Package       | 200-ball FBGA  | 200-ball FBGA                                | 96-ball FBGA  |
|               | Validated PN  | MT53D1024M32D4DT-046 AAT:D                           | MT53D1024M32D4DT-046 AAT:D                   | MT41K256M16TW-093   |
|               | Qty/Board     | 2  | 1  | 3   |
| NAND/e.MMC    | Type          | e.MMC (5.0)  | e.MMC (5.0)                                  |   |
|               | Family        | MTFC   | MTFC   |   |
|               | Density       | 32GB   | 32GB   |   |
|               | Package       | 153-ball VFBGA                                       | 153-ball VFBGA                               |   |
|               | Validated PN  | MTFC32GAKAEFF-AIT                                    | MTFC32GAKAEFF-AIT                            |   |
| NOR           | Type          | Xccela™ Flash (Octal SPI), Serial (Quad SPI)         | Xccela™ Flash (Octal SPI), Serial (Quad SPI) |   |
|               | Family        | MT35X, MT25T, MT25Q                                  | MT35X, MT25T, MT25Q                          |   |
|               | Density       | 512Mb  | 512Mb  |   |
|               | Validated PN  | MT35XU512ABA1G12-0AAT                                | MT35XU512ABA1G12-0AAT                        |   |

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| Micron Memory |               | i.MX 7 Processor Memory |                 |                                  |                     |   |
|---------------|---------------|-------------------------|-----------------|----------------------------------|---------------------|---|
|               |               | i.MX 7                  |                 |                                  |                     | i.MX 7 ULP                                    |
|               |               | SABRE for Smart Devices |                 | Validation Platform              |                     |   |
| DRAM          | Type          | DDR3L                   |                 | LPDDR3                           |                     | LPDDR3  |
|               | Family        | MT41K*                  |                 | EDFA                             |                     | MT52L   |
|               | Density       | 4Gb                     |                 | 16Gb                             |                     | 16Gb  |
|               | Configuration | 256 Meg x 16            |                 | 512 Meg x 32 (2 rank)            |                     | 512 Meg x 32                                  |
|               | Package       | 96-ball VFBGA           |                 | 168-ball PoP (soldered on board) |                     | 168-ball PoP (soldered on PCB)                |
|               | Validated PN  | MT41K256M16HA           |                 | EDFA232A2PF-GD-F-D               |                     | MT52L512M32D2PU-107 WT:B                      |
|               | Qty/Board     | 2                       |                 | 2                                |                     | 1   |
| NAND/e.MMC    | Type          | e.MMC                   | MLC NAND        | e.MMC                            | SLC NAND            | e.MMC (5.0)                                   |
|               | Family        | MTFC                    | MT29F           | MTFC                             | MT29F               | MTFC  |
|               | Density       | 8GB                     | 32Gb            | 8GB                              | 32Gb                | 32GB  |
|               | Package       | 153-ball WFBGA          | 48-pin TSOP     | 153-ball WFBGA                   | 48-pin TSOP         | 153-ball VFBGA                                |
|               | Validated PN  | MTFC8GACAEAM-1M WT      | MT29F32G08CBADB | MTFC8GACAEAM-1M WT               | MT29F32G08ABCDB14   | MTFC8GAKAJCN-1M WT                            |
| NOR           | Type          | Serial (Quad SPI)       |                 | Serial (Quad SPI)                | Serial (Twin Quad)  | Xcelera™ Flash (Octal SPI), Serial (Quad SPI) |
|               | Family        | MT25Q                   |                 | MT25Q                            | MT25TL              | MT35X, MT25T, MT25Q                           |
|               | Density       | 256Mb                   |                 | 256Mb                            | 512Mb               | 512Mb   |
|               | Package       | SO8W                    |                 | SO8W                             | SO16                | 25b BGA                                       |
|               | Validated PN  |                         |                 |                                  | M25TL512HAA1ESF0AAT | MT35XU512ABA1G12-0SITES                       |

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| Micron Memory |               | i.MX 6 Processor Memory  |                                     |                   |                   |                                     |                     |
|---------------|---------------|--|-------------------------------------|-------------------|-------------------|-------------------------------------|---------------------|
|               |               | i.MX 6 Quad/Quad Plus,<br>i.MX 6 Dual/Dual Plus/Dual Lite/Solo |                                     |                   | i.MX 6 Solo Lite  |                                     | i.MX 6 Solo X       |
|               |               | SABRE for Automotive<br>Infotainment                           | SABRE Platform<br>for Smart Devices | Quick Start Board | Evaluation Kit    | WaRP (Wearable<br>Reference Design) | SABRE SDB           |
| DRAM          | Type          | DDR3   | DDR3                                | DDR3              | LPDDR2            | eMCP<br>(LPDDR2 with e.MMC)         | DDR3                |
|               | Family        | MT41K*   | MT41K*                              | MT41K*            | MT42L             | MT29P**                             | MT41K*              |
|               | Density       | 4Gb  | 2Gb                                 | 2Gb               | 8Gb               | 4Gb                                 | 4Gb                 |
|               | Configuration | 256 Meg x 16   | 128 Meg x 16                        | 128 Meg x 16      | 256 Meg x 32      | 256 Meg X 16                        | 256 Meg x 16        |
|               | Package       | 96-ball FBGA   | 96-ball FBGA                        | 96-ball FBGA      | 168-ball VFBGA    | 162-ball VFBGA                      | 96-ball FBGA        |
|               | Validated PN  | MT41J256M16RE  | MT41J128M16HA                       | MT41J128M16HA     | MT42L256M32D2LG   | MT29PZZZ4D4BKESK                    | MT41K256M16HA-125:E |
|               | Qty/Board     | 4  | 4                                   | 4                 | 1                 | 1                                   | 2                   |
| NAND/e.MMC    | Type          | Raw  | e.MMC                               | e.MMC             | e.MMC             | eMCP<br>(LPDDR2 with e.MMC)         | e.MMC               |
|               | Family        | MT29F/MTFC   | MTFC                                | MTFC              | MTFC              | MT29P**                             | MTFC                |
|               | Density       | 64Gb   | 8GB                                 | 8GB               | 8GB               | 4GB                                 | 8GB                 |
|               | Package       | 48-pin TSOP  | 169-ball FBGA                       | 169-ball FBGA     | 169-ball FBGA     | 162-ball VFBGA                      | 153-ball TFBGA      |
|               | Validated PN  | MT29F64G08AFAAA  |                                     |                   |                   | MT29PZZZ4D4BKESK                    | MTFC8GLCDM          |
| NOR           | Type          | Serial (Quad SPI)  | Serial (Quad SPI)                   |                   | Serial (Quad SPI) |                                     | Serial (Quad SPI)   |
|               | Family        | MT25Q  | MT25Q                               |                   | MT25Q             |                                     | MT25Q               |
|               | Density       | 32Mb   | 32Mb                                |                   | 32Mb              |                                     | 256Mb               |
|               | Package       | SO8W   | SO8W                                |                   | SO8W              |                                     | SO8W                |

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| Micron Memory |               | i.MX 6 Processor Memory                |                  |                        |                   |                       |
|---------------|---------------|--|------------------|------------------------|-------------------|-----------------------|
|               |               | i.MX 6 Dual/Quad                       | i.MX 6 Solo      | i.MX 6 UL (Ultra Lite) |                   | i.MX6 ULL             |
|               |               | MX6Q PoP Third-Party Reference Modules | RiOTBoard.ORG    | Validation Module      |                   |                       |
| DRAM          | Type          | LPDDR2 PoP                             | DDR3L            | DDR3/L                 |                   | DDR3/L                |
|               | Family        | MT42L                                  | MT41K*           | MT41K*                 |                   | MT41K                 |
|               | Density       | 8Gb                                    | 4Gb              | 4Gb                    |                   | 4Gb                   |
|               | Configuration | 128 Meg x 64                           | 256 Meg x 16     | 512 Meg x 8            |                   | 256 Meg x 16          |
|               | Package       | 216-ball PoP                           | 96-ball VFBGA    | 96-ball FBGA           |                   | 96-ball VFBGA         |
|               | Validated PN  | MT42L128M64D2LL-25 AT:A                | MT41K256M16HA    | MT41K512M8RH           |                   | MT41K256M16TW-107:P   |
|               | Qty/Board     | 1                                      | 2                | 2                      |                   | 1                     |
| NAND/e.MMC    | Type          | e.MMC                                  | e.MMC            | e.MMC                  | MLC NAND          |                       |
|               | Family        | MTFC                                   | MTFC             | MTFC                   | MT29F             |                       |
|               | Density       | 4GB                                    | 4GB              | 8GB                    | 32Gb (4Gb)        |                       |
|               | Package       | 153-ball VFBGA                         | 153-ball WFBGA   | 153-ball WFBGA         | 48-pin TSOP       |                       |
|               | Validated PN  | MTFC4GACAAAM-4M IT                     | MTFC4GMVEA-1M WT | MTFC8GACAAAM-4M IT     | MT29F32G08CBADAWP |                       |
| NOR           | Type          |  |                  | Serial (Quad SPI)      |                   | Serial (Quad SPI)     |
|               | Family        |  |                  | MT25Q, MT25T           |                   | MT25Q                 |
|               | Density       |  |                  | 256Mb                  |                   | 256Mb                 |
|               | Package       |  |                  | V-PDFN-8 (8mm x 6mm)   |                   | W-PDFN-8              |
|               | Validated PN  |  |                  |                        |                   | MT25QL256ABA1EW9-OSIT |

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Compatibility Guides (Pages 6 of 9)

| Micron Memory |               |                         | Kinetis K Family Processors |     |     |     |     |     |     |     |            |
|---------------|---------------|-------------------------|-----------------------------|-----|-----|-----|-----|-----|-----|-----|------------|
|               |               |                         | K80                         | K70 | K60 | K50 | K40 | K30 | K20 | K10 | E, L, M, W |
| DRAM          | Type          | DDR                     |                             |     |     |     |     |     |     |     |            |
|               | Family        | MT46V                   |                             |     |     |     |     |     |     |     |            |
|               | Density       | 256Mb–1Gb               |                             | ✓   | ✓   |     |     |     |     |     |            |
|               | Configuration | x4, x8, x16             |                             |     |     |     |     |     |     |     |            |
|               | Package       | TSOP, FBGA              |                             |     |     |     |     |     |     |     |            |
| NAND          | Type          | Raw (host ECC required) |                             |     |     |     |     |     |     |     |            |
|               | Family        | MT29F                   |                             |     |     |     |     |     |     |     |            |
|               | Density       | 128Mb–512Gb             |                             | ✓   | ✓   |     |     |     |     |     |            |
|               | Package       | 48-pin TSOP             |                             |     |     |     |     |     |     |     |            |
| NOR           | Type          | Serial                  |                             |     |     |     |     |     |     |     |            |
|               | Family        | MT25Q                   |                             |     |     |     |     |     |     |     |            |
|               | Density       | 8Mb–1Gb                 |                             | ✓   | ✓   | ✓   | ✓   | ✓   | ✓   | ✓   | ✓          |
|               | Package       | Many                    |                             |     |     |     |     |     |     |     |            |
| Xccela™ Flash | Type          | Octal SPI NOR           |                             |     |     |     |     |     |     |     |            |
|               | Family        | MT35X                   |                             |     |     |     |     |     |     |     |            |
|               | Density       | 256Mb–2Gb               | ✓                           |     |     |     |     |     |     |     |            |
|               | Package       | 24-ball T-PBGA          |                             |     |     |     |     |     |     |     |            |

✓ Indicates the interface is compatible with the memory device.

| Micron Memory             |                | i.MX RT Series          |                            |
|---------------------------|----------------|-------------------------|----------------------------|
|                           |                | i.MX RT 10xx            |                            |
| DRAM                      | Type           | SDRAM                   |                            |
|                           | Family         | MT48LC                  |                            |
|                           | Density        | 256Mb                   |                            |
|                           | Configuration  | 16M x 16                |                            |
|                           | Package        | 54-ball FBGA            |                            |
|                           | Validated PN   | MT48LC16M16A2B4-6A IT:G |                            |
|                           | Quantity/board | 1                       |                            |
| NAND/<br>e.MMC            | Type           | SPI NAND                | e.MMC (5.0/ 4.5 usage)     |
|                           | Family         | MT29F                   | MTFC                       |
|                           | Density        | 1GB                     | 8GB                        |
|                           | Package        | 24-ball T-PBGA          | 153-ball VFBGA 11.5x13x1mm |
|                           | Validated PN   | MT29F1G01ABAFD12-IT:F   | MTFC8GAKAJCN-1M WT         |
| Quad-SPI/<br>Parallel NOR | Type           | Quad SPI                | Parallel                   |
|                           | Family         | MT25Q                   | MT28EW                     |
|                           | Density        | 128Mb                   | 128Mb                      |
|                           | Package        | W-PDFN-8                | 64-ball LBGA               |
|                           | Validated PN   | MT25QL128ABA1ESE-0SIT   | MT28EW128ABA1LPC-0SIT      |
| Xccela™ Flash             | Type           | Octal SPI NOR           |                            |
|                           | Family         | MT35X                   |                            |
|                           | Density        | 28Mb–2Gb                |                            |
|                           | Package        | 24-ball T-PBGA 6 x 8mm  |                            |
|                           | Validated PN   | MT35XL512ABA2GSF-0SIT   |                            |

| Micron Memory |               |                   | Vybrid Processors |       |       |
|---------------|---------------|-------------------|-------------------|-------|-------|
|               |               |                   | VF6XX             | VF5XX | VF3XX |
| DRAM          | Type          | DDR3              | LPDDR2            |       |       |
|               | Family        | MT41K*            | MT42L             |       |       |
|               | Density       | 4Gb, 8Gb          | 4Gb               |       |       |
|               | Configuration | x4, x8, x16       | x32, x64          |       |       |
|               | Package       | 78-, 96-ball      | 134-, 253-ball    |       |       |
| NAND          | Type          | Raw               |                   |       |       |
|               | Family        | MT29F             |                   |       |       |
|               | Density       | 128–512Gb         |                   |       |       |
|               | Package       | 48-pin TSOP       |                   |       |       |
| NOR           | Type          | Serial (Quad SPI) |                   |       |       |
|               | Family        | MT25Q             |                   |       |       |
|               | Density       | 128Mb–2Gb         |                   |       |       |
|               | Package       | Many              |                   |       |       |

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| Micron Memory |                | Automotive Processors            |                              |
|---------------|----------------|----------------------------------|------------------------------|
|               |                | ADAS Vision Processor<br>S32V234 | Instrument Cluster<br>MAC57D |
| DRAM          | Type           | LPDDR2                           | DDR2                         |
|               | Family         | MT42L                            | MT47H                        |
|               | Density        | 2Gb                              | 1Gb                          |
|               | Configuration  | 64M x 32                         | 64M x 16                     |
|               | Package        | 134-ball FBGA                    | 84-ball FBGA                 |
|               | Validated PN   | MT42L64M32D1TK-18 AA             | MT47H64M16NF-25E             |
|               | Quantity/board | 2                                | 2                            |
| NOR           | Type           | Serial (Twin Quad SPI)           | Serial (Quad SPI)            |
|               | Family         | MT25TL                           | MT25Q                        |
|               | Density        | 256-1024Mb                       | 128-2048Mb                   |
|               | Package        | SOIC-16, 24-ball T-PBGA          | SOIC-16                      |
|               | Validated PN   |                                  |                              |
| Xccela™ Flash | Type           | Octal SPI                        | Octal SPI                    |
|               | Family         | MT35X                            | MT35X                        |
|               | Density        | 512Mb                            | 512Mb                        |
|               | Package        | 24-ball T-PBGA                   | 24-ball T-PBGA               |
|               | Validated PN   | MT35XU512ABA1G120A-AT            | MT35XL512ABA1G120A-AT        |
| NAND/e.MMC    | Type           | e.MMC                            |                              |
|               | Family         | MTFC                             |                              |
|               | Density        | 8GB                              |                              |
|               | Package        | 153-ball VFBGA                   |                              |
|               | Validated PN   | MTFC8GACAAAM-4M-IT               |                              |

Depending on the application needs, choose between Micron's standard lifecycle products and our Product Longevity Program (PLP) products with extended lifecycle support. For more information, visit [www.micron.com/lifecycle](http://www.micron.com/lifecycle). Products are warranted only to meet Micron's production data sheet specifications. Products, programs and specifications are subject to change without notice. Dates are estimates only. ©2017 Micron Technology, Inc. All rights reserved. All information herein is provided on an "AS IS" basis without warranties of any kind. Micron, the Micron logo and Xccela are trademarks of Micron Technology, Inc. NXP is a trademark of NXP Semiconductors N.V. All other trademarks are property of their respective owners. Rev. L, 5/19 CCMMD-676576390-10755



# Micron® Memory Support for NXP® Networking Platforms

Save yourself time and money—Micron memory comes **validated** on NXP Platforms

| Micron Memory |               | QorIQ Processor Memory    |                           |                           |                           |                           |                           |                           |
|---------------|---------------|---------------------------|---------------------------|---------------------------|---------------------------|---------------------------|---------------------------|---------------------------|
|               |               | Value Tier                | Mid-Range Tier            |                           |                           |                           | High-Performance Tier     |                           |
|               |               | P1010/P1014               | P2022/P2021E              | P2041/P2031               | T2080/T2081               | P408X                     | P5020/P5040               | T4240                     |
| DRAM          | Type          | DDR3/DDR3L                | DDR3                      | DDR3/DDR3L                | DDR3/DDR3L                | DDR3                      | DDR3/DDR3L                | DDR3/DDR4L                |
|               | Family        | MT41                      | MT41                      | MT41                      | MT41                      | MT41                      | MT41                      | MT41                      |
|               | Density       | 4Gb                       | 4Gb                       | 4Gb                       | 4Gb                       | 4Gb                       | 4Gb                       | 4Gb                       |
|               | Configuration | 512 Meg x 8, 256 Meg x 16 | 512 Meg x 8, 256 Meg x 16 | 512 Meg x 8, 256 Meg x 16 | 512 Meg x 8, 256 Meg x 16 | 512 Meg x 8, 256 Meg x 16 | 512 Meg x 8, 256 Meg x 16 | 512 Meg x 8, 256 Meg x 16 |
|               | Package       | 78-ball, 96-ball          | 78-ball, 96-ball          | 78-ball, 96-ball          | 78-ball, 96-ball          | 78-ball, 96-ball          | 78-ball, 96-ball          | 78-ball, 96-ball          |
|               | Base PN       | MT41J256M                 | MT41J256M                 | MT41J256M                 | MT41J256M                 | MT41J256M                 | MT41J256M                 | MT41J256M                 |
| NAND          | Type          | Raw (host ECC required)   | Raw (host ECC required)   | Raw (host ECC required)   | Raw (host ECC required)   |                           | Raw (host ECC required)   | Raw (host ECC required)   |
|               | Family        | MT29F                     | MT29F                     | MT29F                     | MT29F                     |                           | MT29F                     | MT29F                     |
|               | Density       | 128Mb-512Gb               | 128Mb-512Gb               | 128Mb-512Gb               | 128Mb-512Gb               |                           | 128Mb-512Gb               | 128Mb-512Gb               |
|               | Package       | 48-pin TSOP               | 48-pin TSOP               | 48-pin TSOP               | 48-pin TSOP               |                           | 48-pin TSOP               | 48-pin TSOP               |
| NOR           | Type          | Serial                    | Serial                    | Serial                    | Serial                    | Serial                    | Serial                    | Serial                    |
|               | Family        | MT25Q                     | MT25Q                     | MT25Q                     | MT25Q                     | MT25Q                     | MT25Q                     | MT25Q                     |
|               | Density       | 128Mb-2Gb                 | 128Mb-2Gb                 | 128Mb-2Gb                 | 128Mb-2Gb                 | 128Mb-2Gb                 | 128Mb-2Gb                 | 128Mb-2Gb                 |
|               | Package       | Many                      | Many                      | Many                      | Many                      | Many                      | Many                      | Many                      |
| eMMC          | Type          | Managed (JEDEC STD)       | Managed (JEDEC STD)       | Managed (JEDEC STD)       | Managed (JEDEC STD)       | Managed (JEDEC STD)       | Managed (JEDEC STD)       | Managed (JEDEC STD)       |
|               | Family        | MTFC                      | MTFC                      | MTFC                      | MTFC                      | MTFC                      | MTFC                      | MTFC                      |
|               | Density       | 4GB-64GB                  | 4GB-64GB                  | 4GB-64GB                  | 4GB-64GB                  | 4GB-64GB                  | 4GB-64GB                  | 4GB-64GB                  |
|               | Package       | VFBGA, TFBGA, LFBGA       | VFBGA, TFBGA, LFBGA       | VFBGA, TFBGA, LFBGA       | VFBGA, TFBGA, LFBGA       | VFBGA, TFBGA, LFBGA       | VFBGA, TFBGA, LFBGA       | VFBGA, TFBGA, LFBGA       |
| eUSB          | Type          | Managed (USB)             | Managed (USB)             | Managed (USB)             | Managed (USB)             | Managed (USB)             | Managed (USB)             | Managed (USB)             |
|               | Family        | MTEDC                     | MTEDC                     | MTEDC                     | MTEDC                     | MTEDC                     | MTEDC                     | MTEDC                     |
|               | Density       | 2GB-16GB                  | 2GB-16GB                  | 2GB-16GB                  | 2GB-16GB                  | 2GB-16GB                  | 2GB-16GB                  | 2GB-16GB                  |
|               | Package       | 36.9mm x 26.6mm           | 36.9mm x 26.6mm           | 36.9mm x 26.6mm           | 36.9mm x 26.6mm           | 36.9mm x 26.6mm           | 36.9mm x 26.6mm           | 36.9mm x 26.6mm           |
| SATA SSD      | Type          | Managed (SATA)            |                           | Managed (SATA)            | Managed (SATA)            |                           | Managed (SATA)            | Managed (SATA)            |
|               | Family        | MTFDD                     |                           | MTFDD                     | MTFDD                     |                           | MTFDD                     | MTFDD                     |
|               | Density       | 100GB-960GB               |                           | 100GB-960GB               | 100GB-960GB               |                           | 100GB-960GB               | 100GB-960GB               |
|               | Package       | 2.5" drive, 7mm height    |                           | 2.5" drive, 7mm height    | 2.5" drive, 7mm height    |                           | 2.5" drive, 7mm height    | 2.5" drive, 7mm height    |

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# Micron® Memory Support for NXP® Networking Platforms

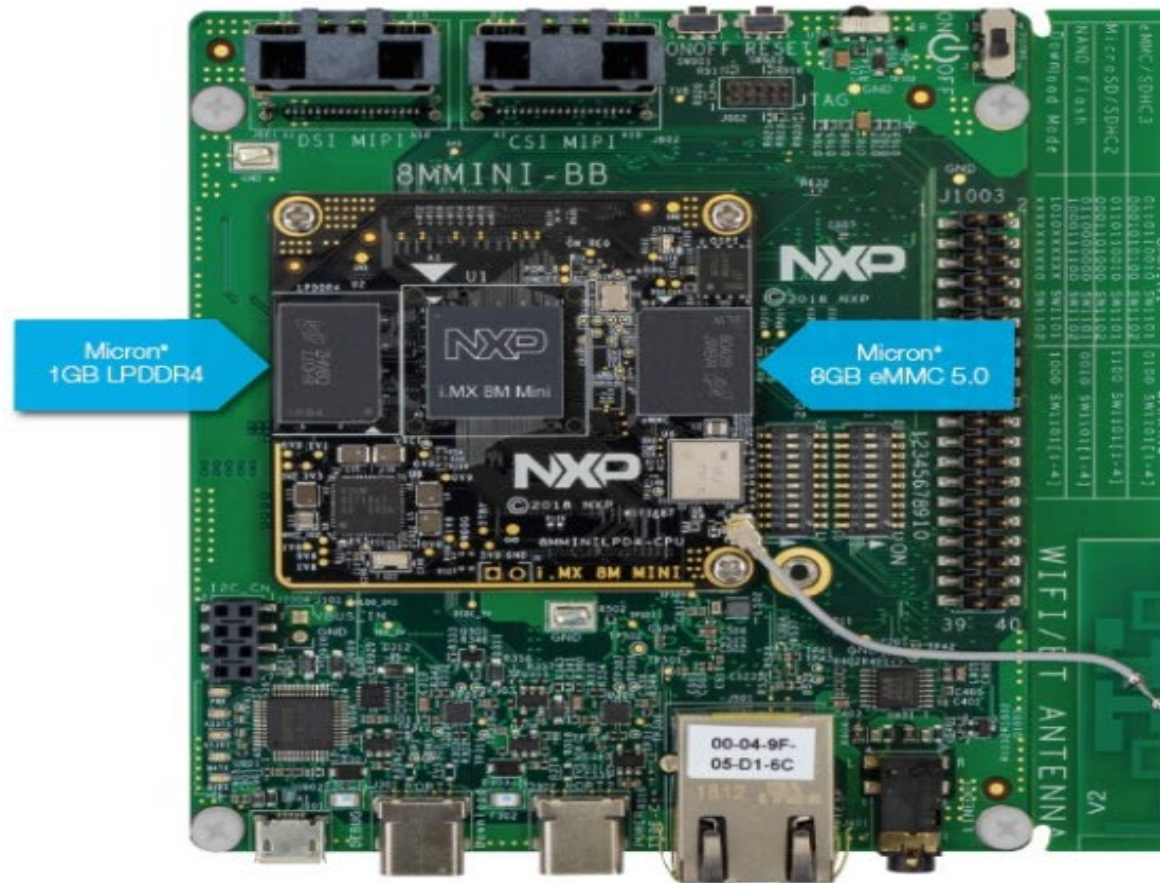
Save yourself time and money—Micron memory comes *validated* on NXP Platforms

| Micron Memory |               | Q or IQ Processor Memory |                         |                            |                         |
|---------------|---------------|--------------------------|-------------------------|----------------------------|-------------------------|
|               |               | Value Tier               |                         |                            | Mid-Range Tier          |
|               |               | LS1020/LS1021/LS1022     | T1023/T1024             | T1020, T1022, T1040, T1042 | LS2085                  |
| DRAM          | Type          | DDR3L                    | DDR3L UDIMM             | DDR3L UDIMM                | DDR4 UDIMM              |
|               | Density       | 4Gb                      | 4GB (x72, ECC, DR)      | 4GB (x72, ECC, DR)         | 8GB (x72, ECC, DR)      |
|               | Configuration | 256 Meg x 16             | 4GB (512 Meg x 72)      | 4GB (512 Meg x 72)         | 1 Gig x 72              |
|               | Package       | 96-ball VFBGA            | UDIMM (Dual Rank)       | UDIMM (Dual Rank)          | UDIMM (Dual Rank)       |
|               | Part Number   | MT41K256M16HA-125:E      | MT18KSF51272AZ-1G6      | MT18KSF51272AZ-1G6         | MTA18ASF1G72AZ-2G1A1    |
| NAND          | Type          |                          | Raw (host ECC required) | Raw (host ECC required)    | Raw (host ECC required) |
|               | Density       |                          | 8Gb                     | 8Gb                        | 16Gb                    |
|               | Package       |                          | 48-pin TSOP             | 48-pin TSOP                | 48-pin TSOP             |
|               | Part Number   |                          | MT29F8G08ABBCAH4        | MT29F8G08ABABAWP-ITX:B     | MT29F16G08ABABA         |
| NOR           | Type          | Serial                   | Serial                  | Serial                     | Serial                  |
|               | Density       | 128Mb                    | 512Mb                   | 512Mb                      | 512Mb                   |
|               | Package       | 24-ball TBGA             | SO8, SO16, 24-ball TBGA | SO8, SO16, 24-ball TBGA    | SOP2-16/300 mils        |
|               | Part Number   |                          | MT25QL512ABA1ESF        |                            |                         |
| eMMC          | Type          | Managed (JEDEC STD)      |                         | Managed (JEDEC STD)        | Managed (JEDEC STD)     |
|               | Density       | 4GB–64GB                 |                         | 4GB–64GB                   | 4GB–64GB                |
|               | Package       | VFBGA, TFBGA, LFBGA      |                         | VFBGA, TFBGA, LFBGA        | VFBGA, TFBGA, LFBGA     |
|               | Part Number   | MTFC                     |                         | MTFC                       | MTFC                    |
| eUSB          | Type          | Managed (USB)            | Managed (USB)           | Managed (USB)              | Managed (USB)           |
|               | Density       | 2GB–16GB                 | 2GB–16GB                | 2GB–16GB                   | 2GB–16GB                |
|               | Package       | 36.9mm x 26.6mm          | 36.9mm x 26.6mm         | 36.9mm x 26.6mm            | 36.9mm x 26.6mm         |
|               | Part Number   | MTEDC                    | MTEDC                   | MTEDC                      | MTEDC                   |
| SATA SSD      | Type          | Managed (SATA)           |                         | Managed (SATA)             | Managed (SATA)          |
|               | Density       | 100GB–960GB              |                         | 100GB–960GB                | 100GB–960GB             |
|               | Package       | 2.5" drive, 7mm height   |                         | 2.5" drive, 7mm height     | 2.5" drive, 7mm height  |
|               | Part Number   | MTFDD                    |                         | MTFDD                      | MTFDD                   |

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# i.MX8 Mini

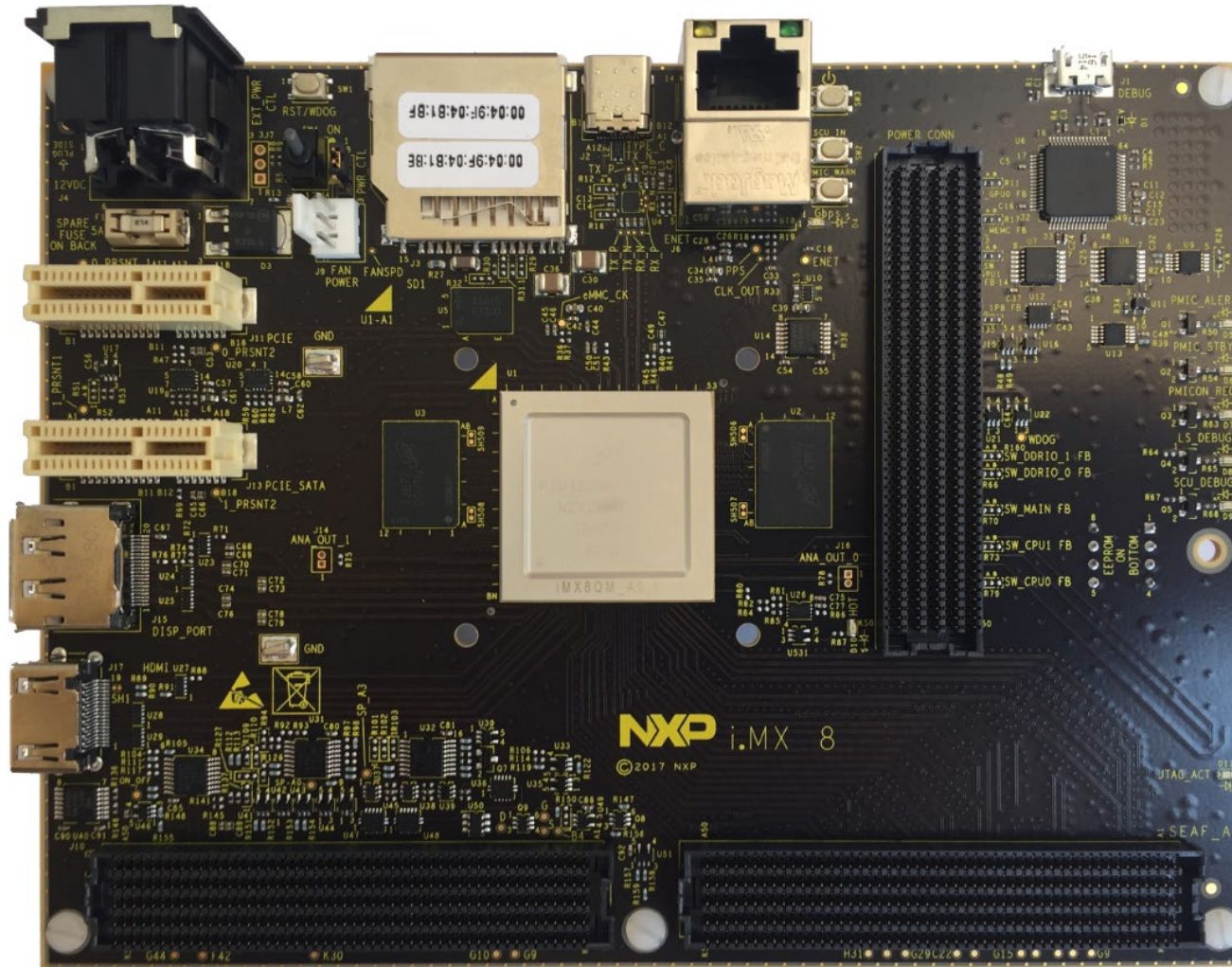


## Micron Memories Validated:

- 1GB LPDDR4
- 8GB e.MMC 5.0

Please contact your closest sales office  
for the latest Micron part number.

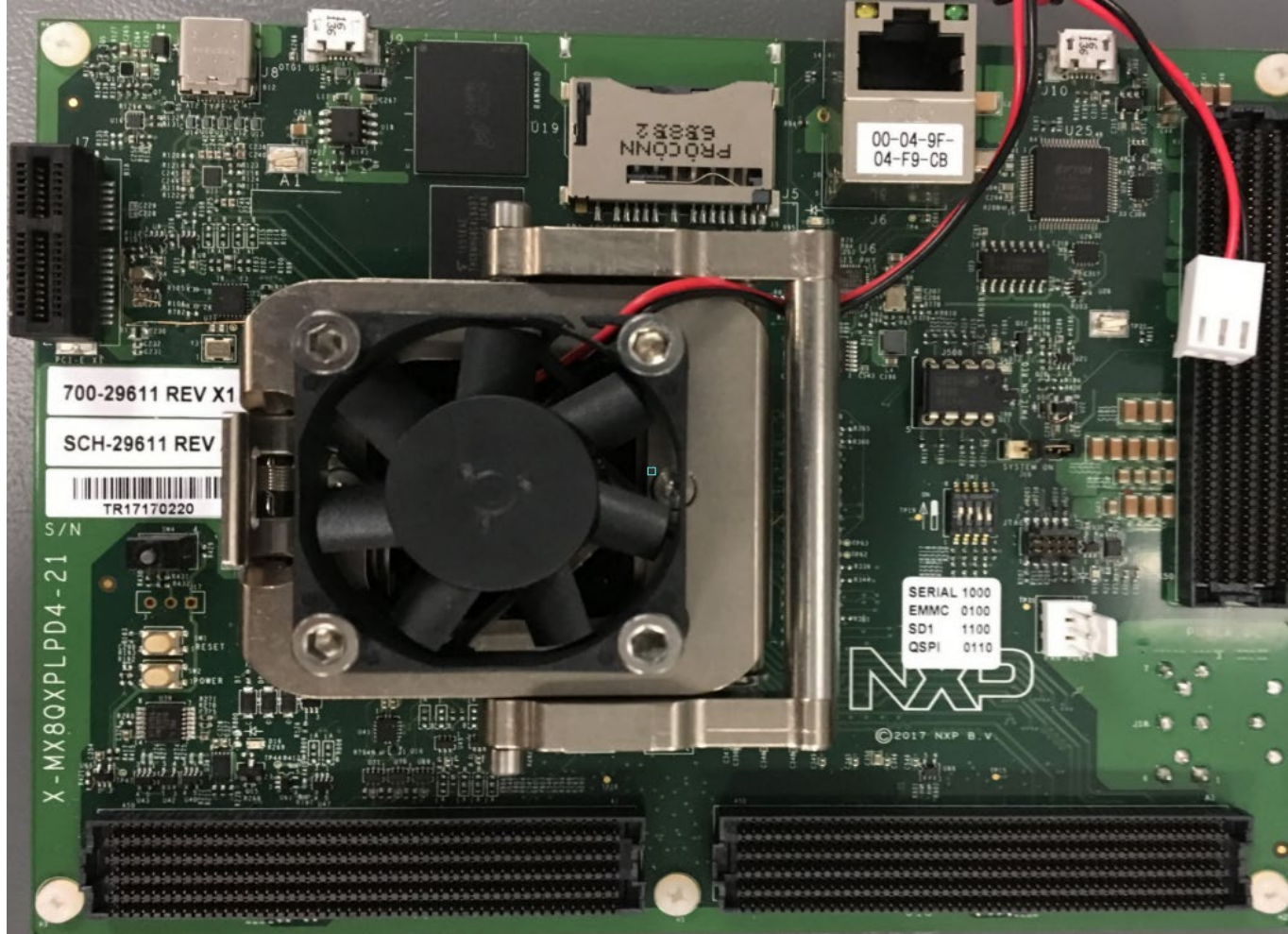
# i.MX8 Quad Max



- i.MX8 QM Features Micron's:**
- LPDDR4 (up to 8GB)
  - Xccela™ Octal Flash, Q-SPI
  - 32GB eMMC5.0 (back side)

Board photo of released MX8 Quad Max

# i.MX8 Quad X Plus

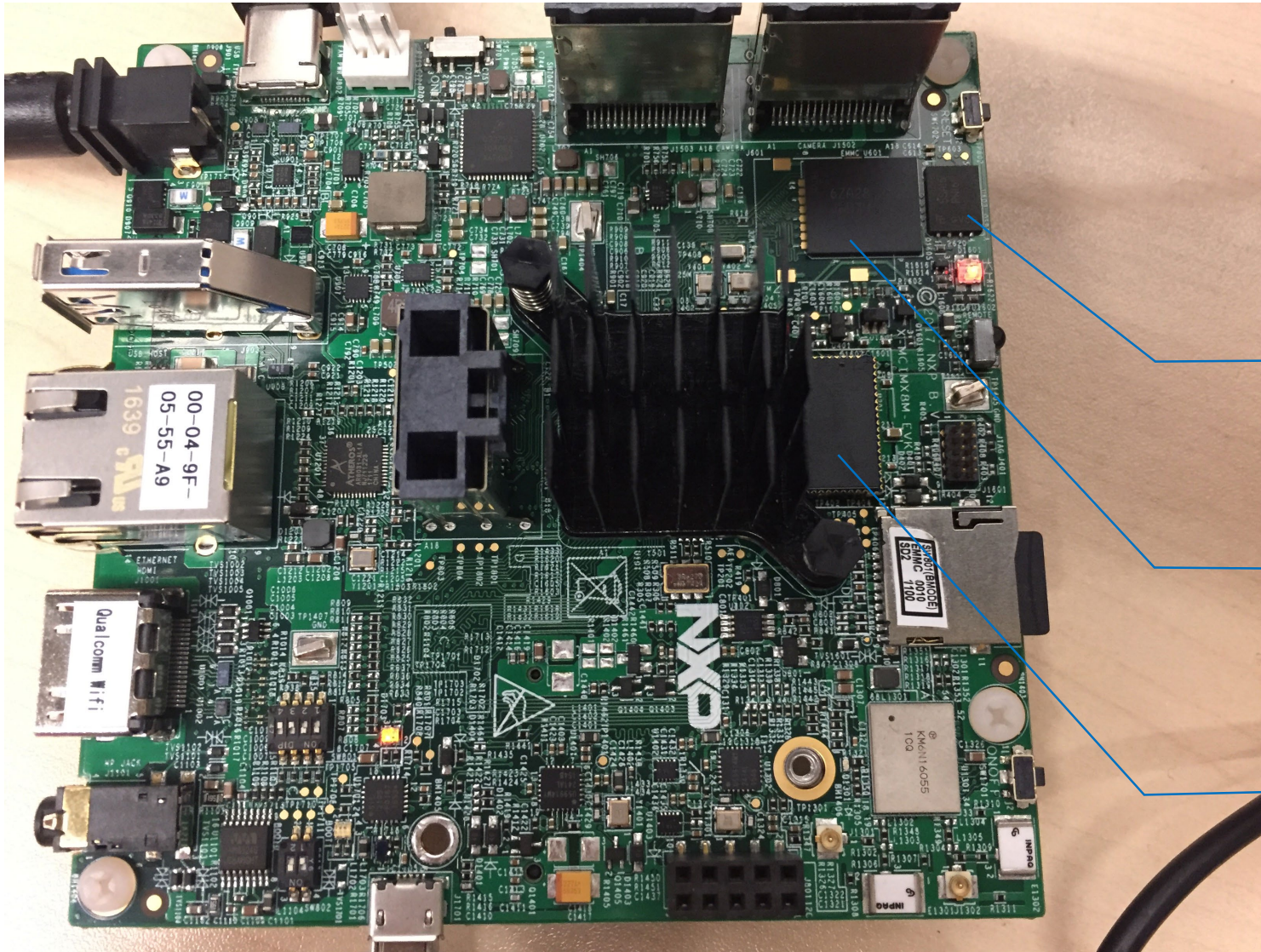


- i.MX8 QXP Features Micron's:**
- LPDDR4 (up to 8GB)
  - Xccela™ Octal Flash, Q-SPI
  - 32GB eMMC5.0 (back side)

Board photo of released MX8 Quad X Plus



# i.MX8 M



i.MX8 M has validated Micron's:

- 3GB LPDDR4
- 256MbQuad SPI
- 16GB eMMC5.0

Quad SPI Flash  
MT25QL256ABA1EW9-0SIT

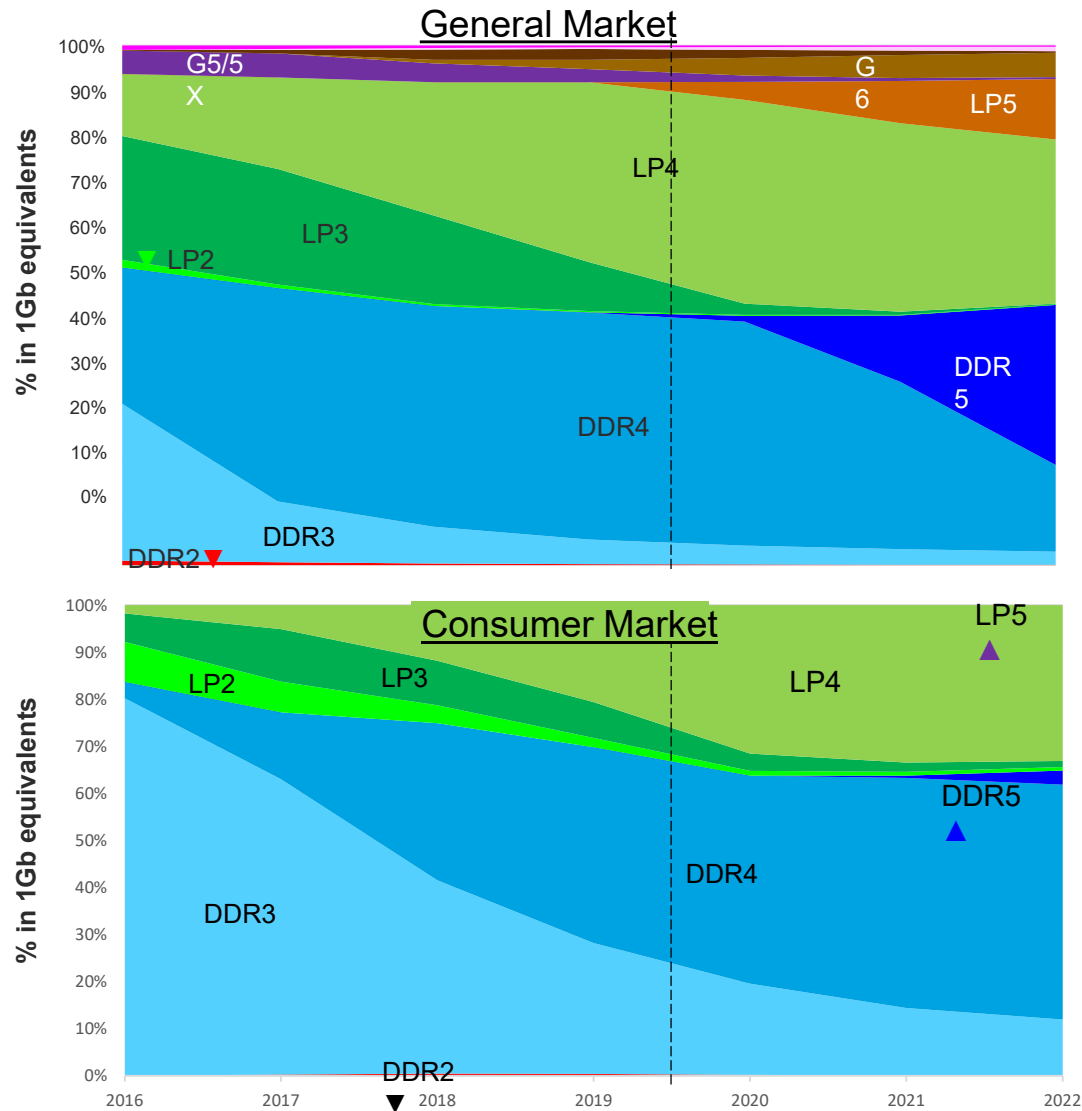
16GB e.MMC  
MTFC16GAKECN-2M WT

3GB LPDDR4  
MT53B768M32D4NQ-062 WT:B

Board photo of released MX8 M

# DRAM Overview

# DRAM Market Trends, General Market vs Consumer Adoption



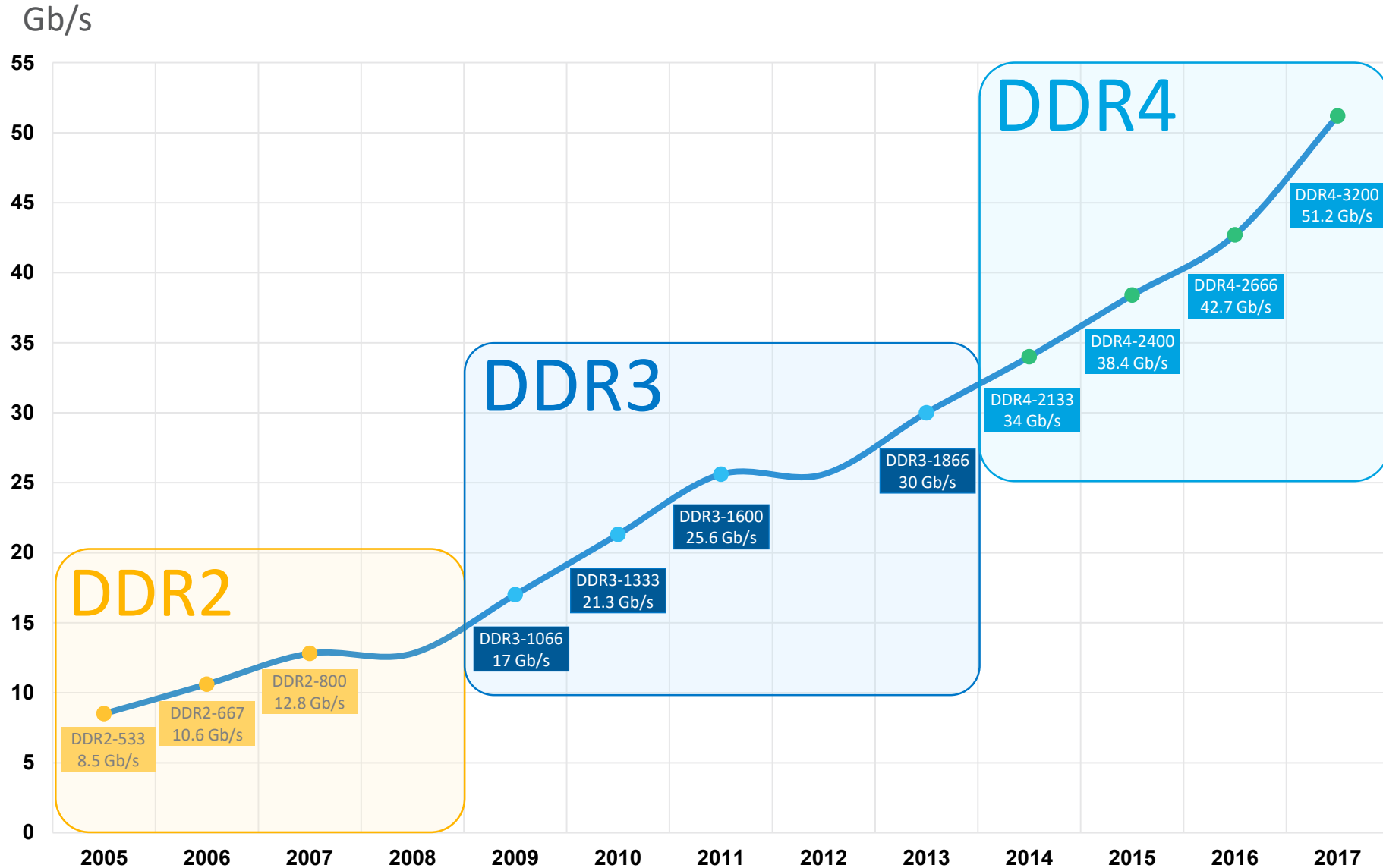
## General Market:

- DDR4 dominant interface for devices w/out batteries
- Increased LPDRAM adoption outside of mobile handsets driven by Tablets & other Client apps
  - LPDRAM shipments >50% of total market at the end of CY'16
- DDR5/LPDDR5 early adoption projected to start in late CY'19

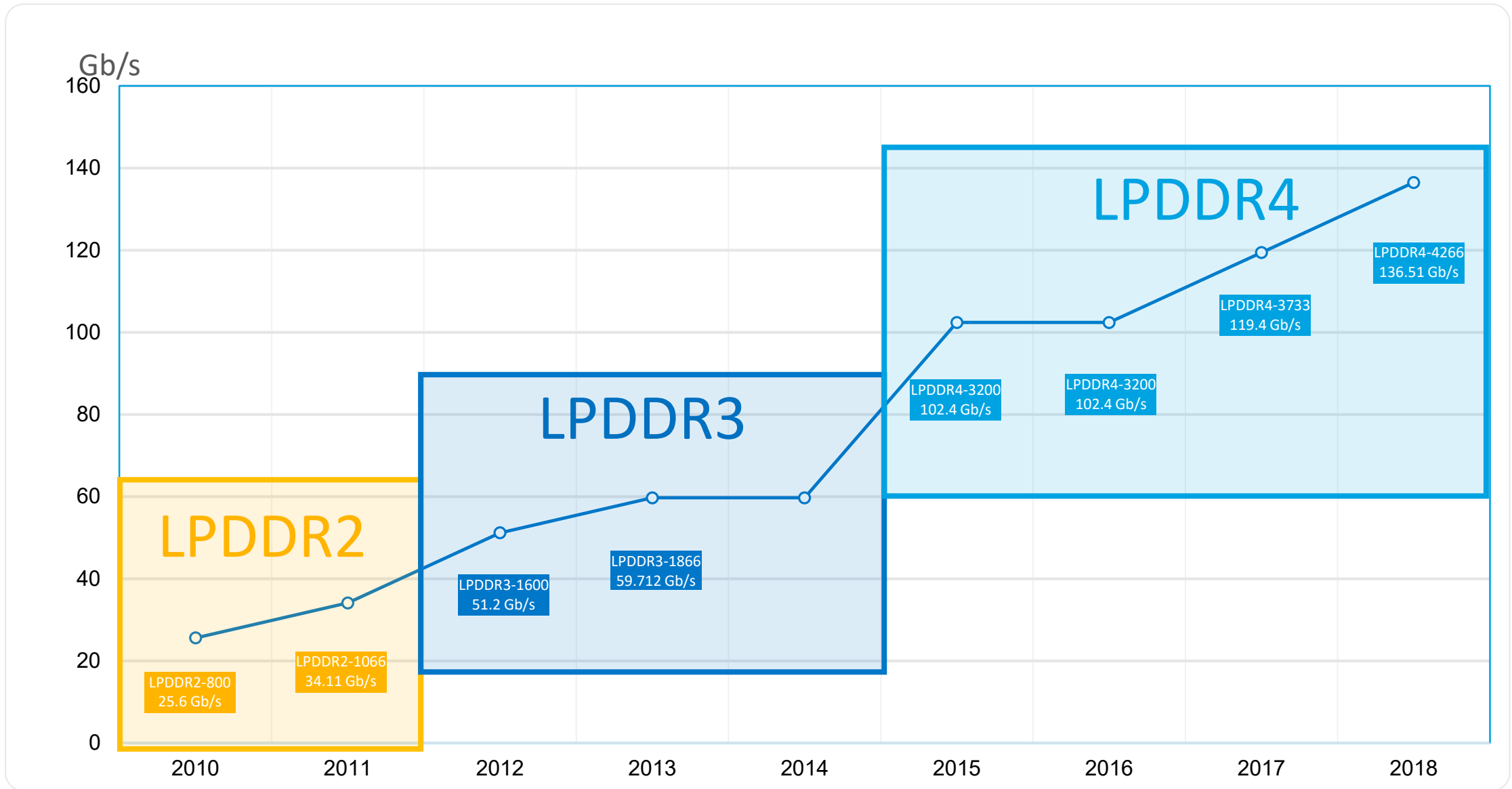
## Consumer Market:

- Main volume expected to continue to be 4Gb DDR3 for near future, shifting to 8Gb DDR4 for higher density and performance
- LPDRAM adoption primarily for Consumer battery driven applications such as DSCs / DVCs, AR/VR, Home Automation
  - LPDDR4 adoption is expected to advance to new applications due to higher bandwidth requirements: DTV, STB, Smart IoT Gateway/Hub
  - Note LP4 densities shown represent die densities (vs. package)

# DRAM Performance Improvements Over Time (IO x16)



# LPDDR Performance Improvements Over Time (IO x32)



# LPDDRx and DDRx SDRAM Feature Comparison

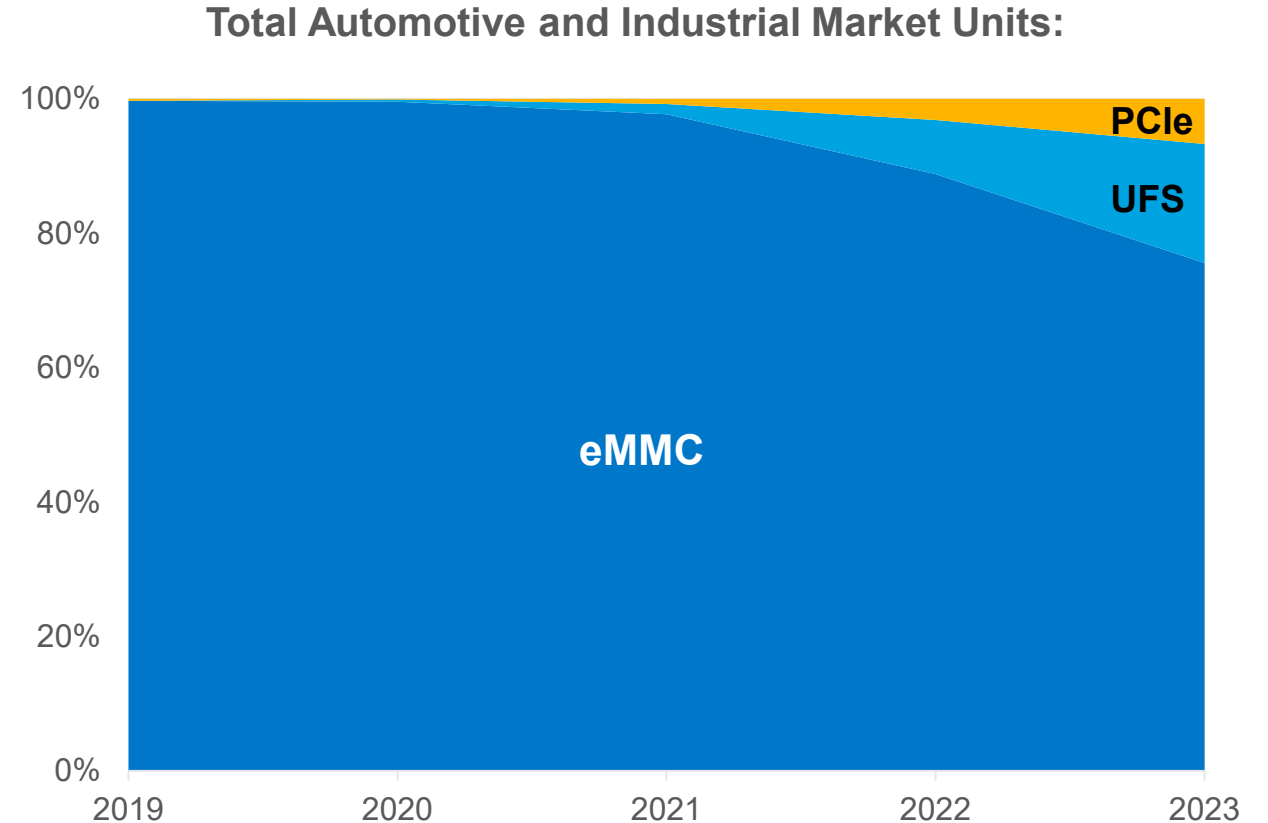
| Type                            | LPDDR2  | LPDDR3  | LPDDR4/4X   | DDR2                               | DDR3/DDR3L                         | DDR4                               |
|---------------------------------|---|---|---|------------------------------------|------------------------------------|------------------------------------|
| Die Density                     | Up to 8Gb                                       | Up to 32Gb                                      | Up to 32Gb  | Up to 2Gb                          | Up to 8Gb                          | Up to 16Gb                         |
| Core Voltage (V <sub>dd</sub> ) | 1.2V<br>1.8V WL supply req.                     | 1.2V<br>1.8V WL supply req.                     | 1.1V/1.0V<br>1.8V WL supply req.  | 1.8V<br>1.55V                      | 1.5V/1.35V                         | 1.2V<br>Separate WL supply<br>2.5V |
| I/O Voltage                     | 1.2V  | 1.2V  | 1.1V (4X = 0.6V)  | Same as VDD                        | Same as VDD                        | Same as VDD                        |
| Max Clock Freq. /Data rate      | 533MHz/DDR1066                                  | 800MHz/DDR1600                                  | 2133MHz/DDR4267   | 533MHz/DDR1066                     | 1066MHz/DDR2100                    | 1600MHz+/DDR3200+                  |
| Burst Lengths                   | 4, 8, 16  | 8   | 16, 32  | 4, 8                               | BC4, 8                             | BC4, 8                             |
| Configurations                  | x16, x32  | x16, x32  | 2Ch x16   | x4, x8, x16                        | x4, x8, x16                        | x4, x8, x16                        |
| Address/ Command Signals        | 14 pins<br>(Mux'd command address)              | 14 pins<br>(Mux'd command address)              | 10 pins per channel<br>(Mux'd command Address)  | 25 pins                            | 27 pins                            | 29 pins<br>(partial mux'd)         |
| Address/ Command Data Rate      | DDR<br>(both rising and falling edges of clock) | DDR<br>(both rising and falling edges of clock) | SDR<br>(rising edge of clock only)  | SDR<br>(rising edge of clock only) | SDR<br>(rising edge of clock only) | SDR<br>(rising edge of clock only) |
| On Die Temperature Sensor       | Yes   | Yes   | Yes   | No                                 | Optional/RS                        | Yes                                |
| DPD (Deep power-down mode)      | Yes   | Yes   | No  | No                                 | No                                 | No                                 |
| Package Options                 | POP, MCP, discrete                              | POP, MCP, discrete                              | PoP, MCP, discrete  | Discrete                           | Discrete                           | Discrete                           |
| Product/Temp. Grades            | CT, IT, AIT, AT, AAT                            | CT, IT, AIT, AT, AAT                            | PoP, MCP, discrete<br>WT (-25' to 85'C)<br>AAT (-40C to 105C)<br>AUT (-40'C to 125'C) | CT, IT, AIT, AT, AAT               | CT, IT, AIT, AT, AAT,<br>AUT       | CT, IT, AIT, AT, AAT,<br>AUT       |

# Non-Volatile Details

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# Managed NAND Market

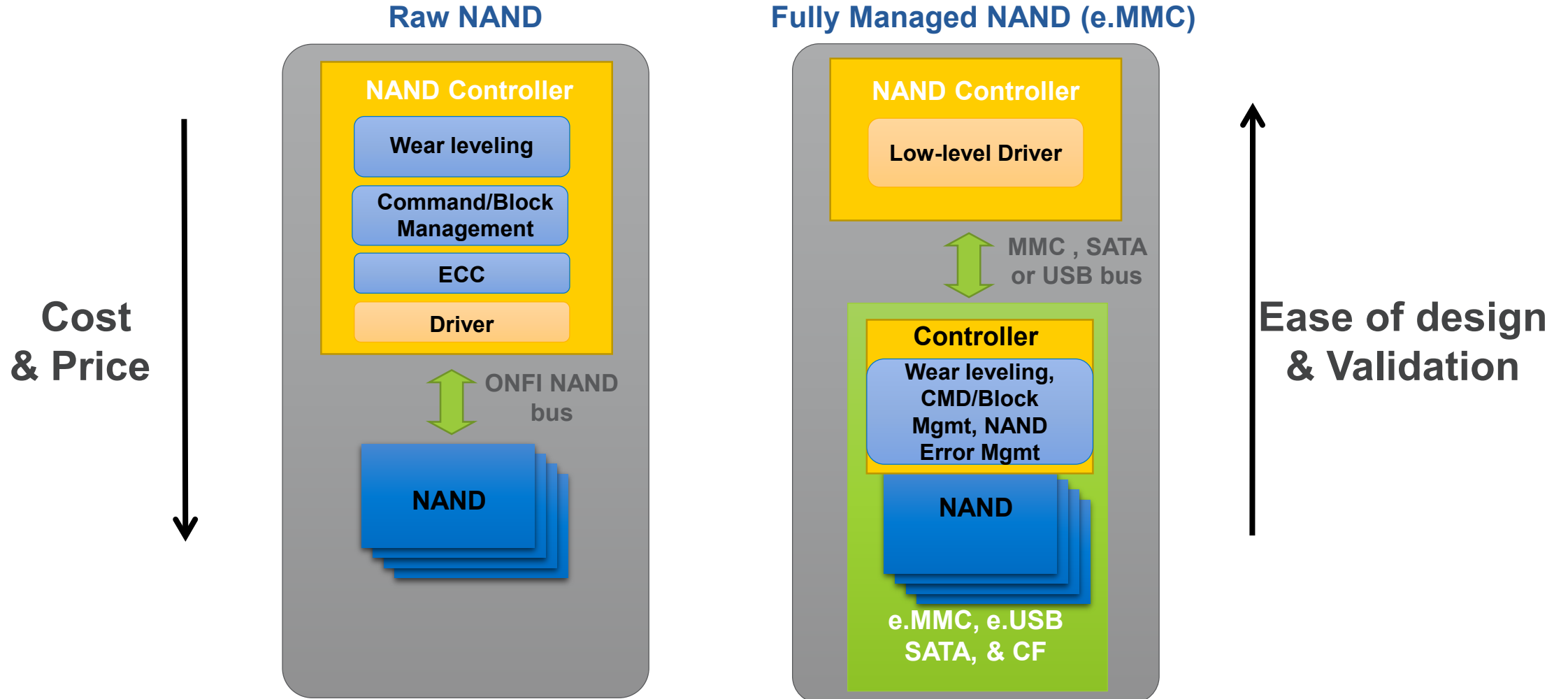
- Continued strong deployment of eMMC
  - Sufficient performance for low/mid end applications
- UFS driven by mobile
  - Higher performance / density vs eMMC
  - Choice for upcoming mid end/premium IVI platforms
- PCIe NVMe SSD future w/ central storage
  - Highest performance and density vs UFS and eMMC



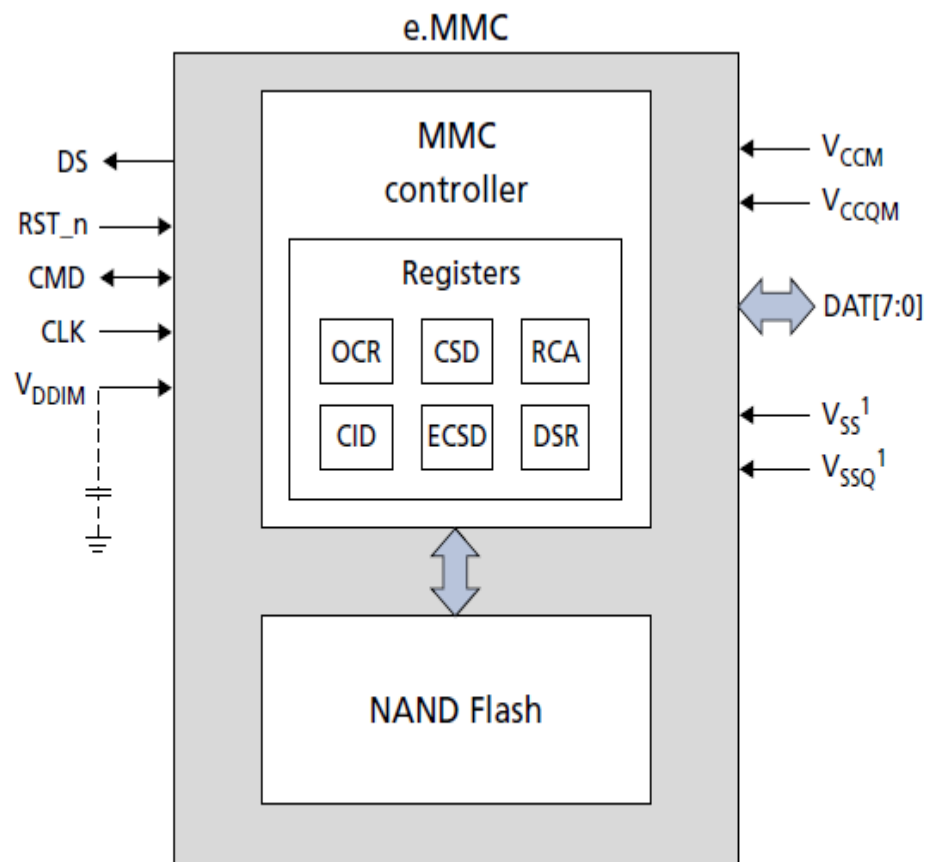


# e.MMC Fully Managed NAND

PROVIDES REDUCED DESIGN EFFORT FOR MINIMAL COST

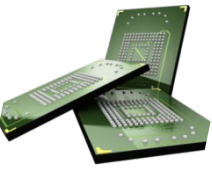


# e.MMC



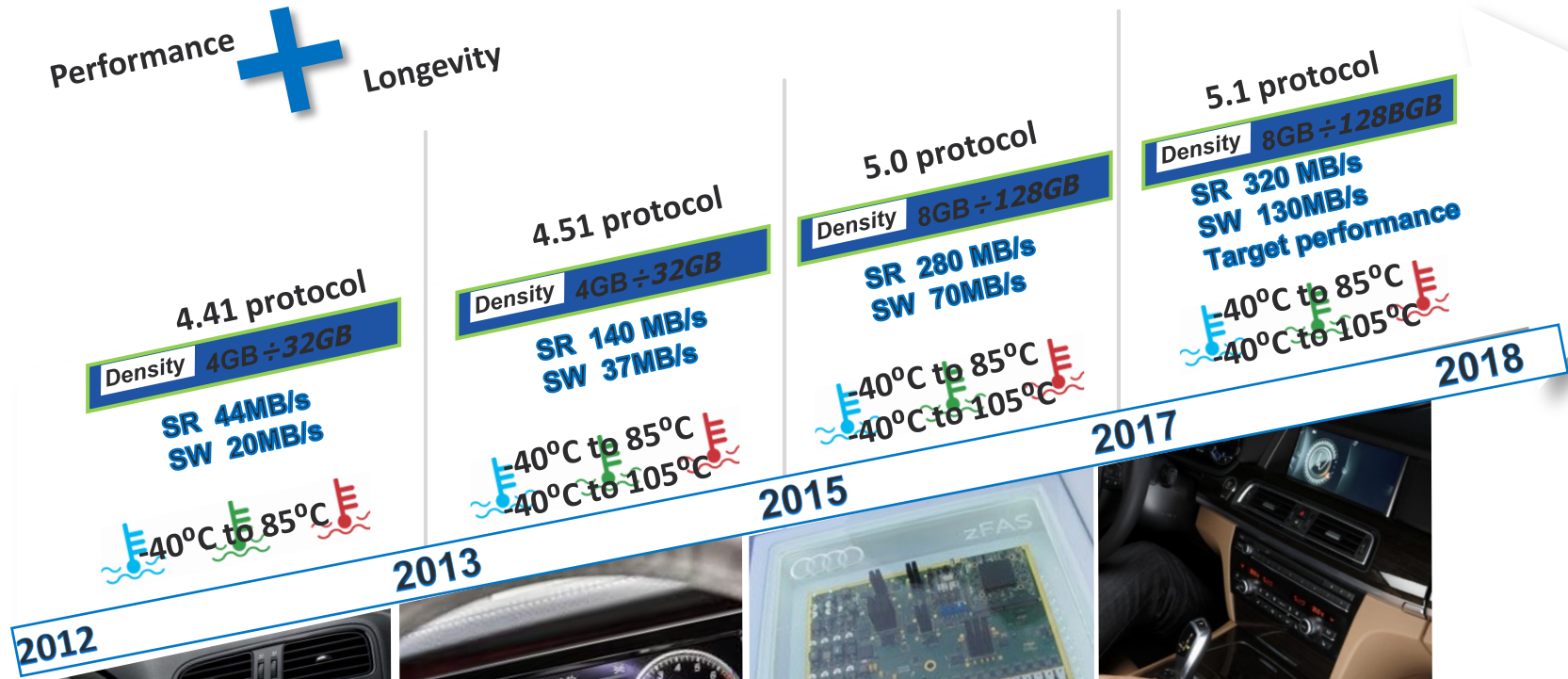
Note: 1.  $V_{SS}$  and  $V_{SSQ}$  are internally connected.

| Symbol      | Type   | Description   |
|-------------|--------|---|
| CLK         | Input  | Clock: Each cycle of the clock directs a transfer on the command line and on the data line(s). The frequency can vary between the minimum and the maximum clock frequency.  |
| RST_n       | Input  | Reset: The RST_n signal is used by the host for resetting the device, moving the device to the pre-idle state. By default, the RST_n signal is temporarily disabled in the device. The host must set ECSD register byte 162, bits[1:0] to 0x1 to enable this functionality before the host can use it.  |
| CMD         | I/O    | Command: This signal is a bidirectional command channel used for command and response transfers. The CMD signal has two bus modes: open-drain mode and push-pull mode. Commands are sent from the MMC host to the device, and responses are sent from the device to the host.   |
| DAT[7:0]    | I/O    | Data I/O: These are bidirectional data signals. The DAT signals operate in push-pull mode. By default, after power-on or assertion of the RST_n signal, only DAT0 is used for data transfer. The MMC controller can configure a wider data bus for data transfer either using DAT[3:0] (4-bit mode) or DAT[7:0] (8-bit mode). The device includes internal pull-up resistors for data lines DAT[7:1]. Immediately after entering the 4-bit mode, the device disconnects the internal pull-up resistors on the DAT[3:1] lines. Upon entering the 8-bit mode, the device disconnects the internal pull-ups on the DAT[7:1] lines. |
| DS          | Output | Data strobe: Generated by the device and used for data output and CRC status response output in HS400 mode. The frequency of this signal follows the frequency of CLK. For data output, each cycle of this signal directs two bits transfer (2x) on the data, one bit for the positive edge and the other bit for the negative edge. For CRC status response output, the CRC status is latched on the positive edge only, and is "Don't Care" on the negative edge.   |
| $V_{CC}$    | Supply | $V_{CC}$ : NAND interface (I/F) I/O and NAND Flash power supply.  |
| $V_{CCQ}$   | Supply | $V_{CCQ}$ : e.MMC controller core and e.MMC I/F I/O power supply.   |
| $V_{SS}^1$  | Supply | $V_{SS}$ : NAND I/F I/O and NAND Flash ground connection.   |
| $V_{SSQ}^1$ | Supply | $V_{SSQ}$ : e.MMC controller core and e.MMC I/F ground connection.  |
| $V_{DDIM}$  |        | Internal voltage node. Do not tie to supply voltage or ground.  |
| NC          | -      | No connect: No internal connection is present.  |
| RFU         | -      | Reserved for future use: No internal connection is present. Leave it floating externally.   |



# Enjoy Micron Automotive eMMC comprehensive Product Portfolio

Performance + Longevity



PCIe / NVMe  
UFS 2.x

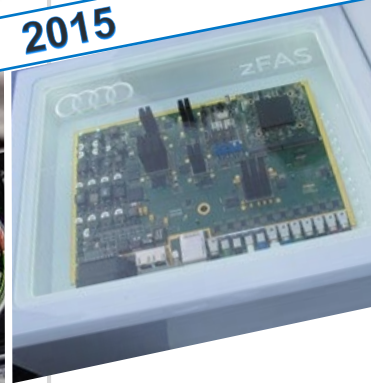
2012



2013



2015



2017



2018

Reliability



Package JEDEC  
100b, 1.0mm ball pitch  
153b-169b, 0.5mm ball pitch

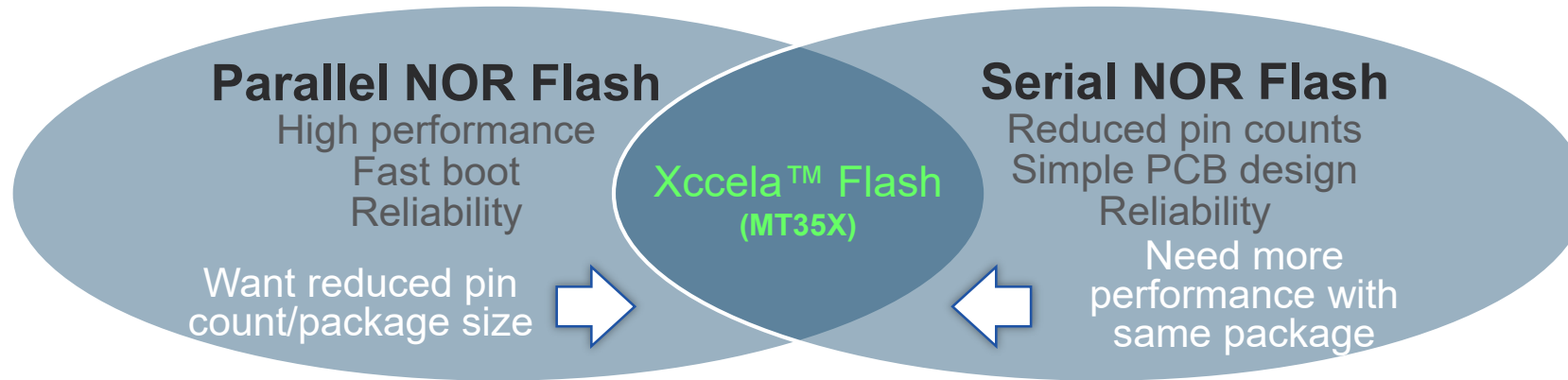
# SSD Form Factors

2100AI and 2100AT

| Parameter       | M.2 (PCIe)  | μSSD (PCIe)  |
|-----------------|---|--|
| Capacities (GB) | 256GB/512GB/1TB   | 64GB/128GB/256GB/512GB/1TB                           |
| Interface       | PCIe Gen3 x4  | PCIe Gen3 x4   |
| Specification   | PCIe M.2 Spec. Rev. 1.1   | PCIe BGA Spec. Rev. 1.1                              |
| Dimensions      | (L) 30 mm<br>(W) 22 mm<br>(H) 1.2 mm (from the top); 1.6 mm for 1TB | (L) 20 mm<br>(W) 16 mm<br>(H) 1.2 mm; 1.6 mm for 1TB |
| Other           | M key   | 291 Balls  |



# Xccela™ Flash: Best of Parallel and Serial NOR Flash



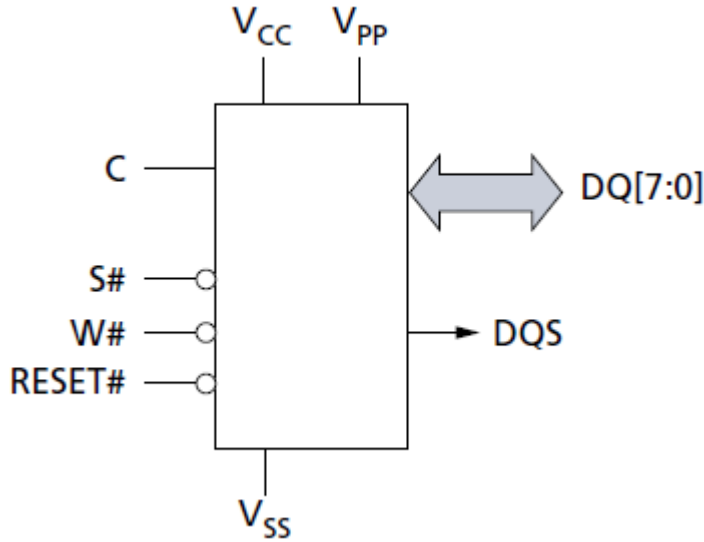
|                          | 512Mb Parallel NOR MT28EW                | 512Mb Quad-SPI MT25Q                         | 512Mb Twin-Quad MT25T                       | 512Mb Xccela Flash MT35X                            |
|--------------------------|--|--|---|---|
| Bandwidth                | 80MB/s<br>(Page mode, async, x16)        | 90MB/s<br>(90MHz, DDR mode)                  | 180MB/s<br>(90MHz, DDR mode)                | <b>400MB/s<br/>(200MHz, DDR mode)</b>               |
| Initial Word Access Time | 95ns (x16)                               | 139ns (1.8V, 4-bit)<br>157ns (1.8V, 16-bits) | 139ns (1.8V, 8-bit)<br>145ns (1.8V, 16-bit) | <b>85ns (1.8V, 8-bit)<br/>87.5ns (1.8V, 16-bit)</b> |
| Subsequent Word Access   | 20ns (16-bits)<br>(95ns across 32B page) | 6ns (4-bits)<br>24ns (16-bits)               | 6ns (8-bits)<br>12ns (16-bits)              | <b>2.5ns (8-bits)<br/>5ns (16-bits)</b>             |
| Package and Pins         | 64-TBGA (11x13mm)<br>50 Active Pins      | 24-BGA (6x8mm)<br>6 Active Pins              | 24-BGA (6x8mm)<br>11 Active Pins            | <b>24-BGA (6x8mm)<br/>11 Active Pins</b>            |
| Energy Per Bit           | 101 pJ/bit                               | 41 pJ/bit                                    | 41 pJ/bit                                   | <b>28 pJ/bit</b>                                    |

**5X THE PERFORMANCE, 4X FEWER PINS, 3X LESS ENERGY, AND 2X SMALLER PACKAGE\***

Source Micron datasheets

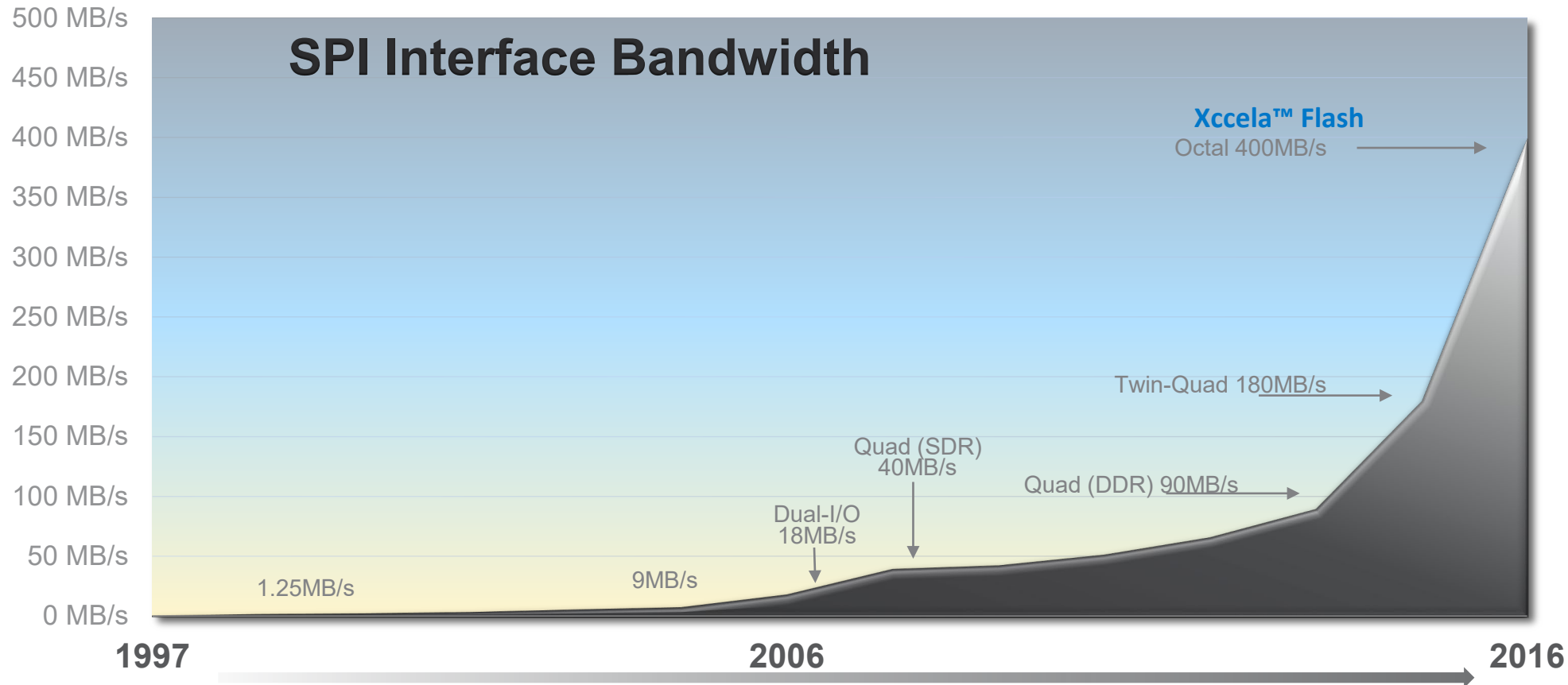
\* Compared to Page Mode Parallel NOR

# MT35X (Octal) aka Xccela™ Flash



| Symbol          | Type   | Description   |
|-----------------|--------|---|
| C               | Input  | <b>Clock:</b> Provides timing for the serial interface. Command, address, or data inputs are latched on the rising edge of C. Data is shifted out on the falling edge of C.   |
| S#              | Input  | <b>Chip select:</b> When S# is LOW, device is selected and in active power mode. Operations are initiated on the falling edge of S#. When S# is HIGH, device is deselected, DQ pins are tri-stated, and unless an internal WRITE operation is in progress, device enters standby mode.  |
| RESET#          | Input  | <b>RESET:</b> Resets device to its default settings, such as after a volatile configuration register setting which then requires a return to the device default setting. Reset is optional when device settings are fixed by nonvolatile configuration register settings and always synchronized with the host. This pad is internally tied to weak pull-up so the pin can be floated.  |
| W#              | Input  | <b>Write protect:</b> This input signal is used to freeze the status register in conjunction with the enable/disable bit of the status register. When the enable/disable bit of the status register is set to 1 and the W# signal is driven LOW, the status register nonvolatile bits become read-only and the WRITE STATUS REGISTER operation will not execute. During the extended-SPI protocol with OCTAL READ/PROGRAM instructions, and during octal DDR protocol, this pin functions as an input/output (DQ2 functionality). This signal does not have internal pull-ups, it cannot be left floated and must be driven, even if none of W#/DQ2 function is used. |
| DQ[7:0]         | I/O    | <b>Serial I/O:</b> Bidirectional signals that transfer address, data, and command information. In extended-SPI protocol, DQ0 functions as input and DQ1 as output. DQ[7:2] are not used. In octal protocol, input/output on DQ[7:0] depends on the command. Input can be latched on the rising edge of C (SDR) or on both edges of C (DDR). Data can be shifted out on the falling edge of C (SDR) or on both edges of C (DDR). In octal DDR, DQ[7:0] always function as I/O, input is latched on both edges of C, and output is shifted out on both edges of C. DQ2 is used also as write protection control.  |
| DQS             | Output | <b>Data Strobe:</b> Indicates output data valid for DDR modes and is required to support high speed data output. Not required in extended-SPI protocol except to achieve high frequency for specific DDR commands.  |
| V <sub>CC</sub> | Supply | <b>Supply voltage:</b> Core and I/O supply.   |
| V <sub>PP</sub> | Supply | <b>Supply voltage:</b> If V <sub>PP</sub> is in the voltage range of V <sub>PPH</sub> , the signal acts as an additional power supply for programming operation, as defined in the Operating Conditions table. The V <sub>PP</sub> pad will be internally pulled up to V <sub>CC</sub> , so customer can leave V <sub>PP</sub> pin floated if not used.   |
| V <sub>SS</sub> | Supply | <b>Ground:</b> Core and I/O ground connection. V <sub>SS</sub> is the reference for the V <sub>CC</sub> supply voltage.   |

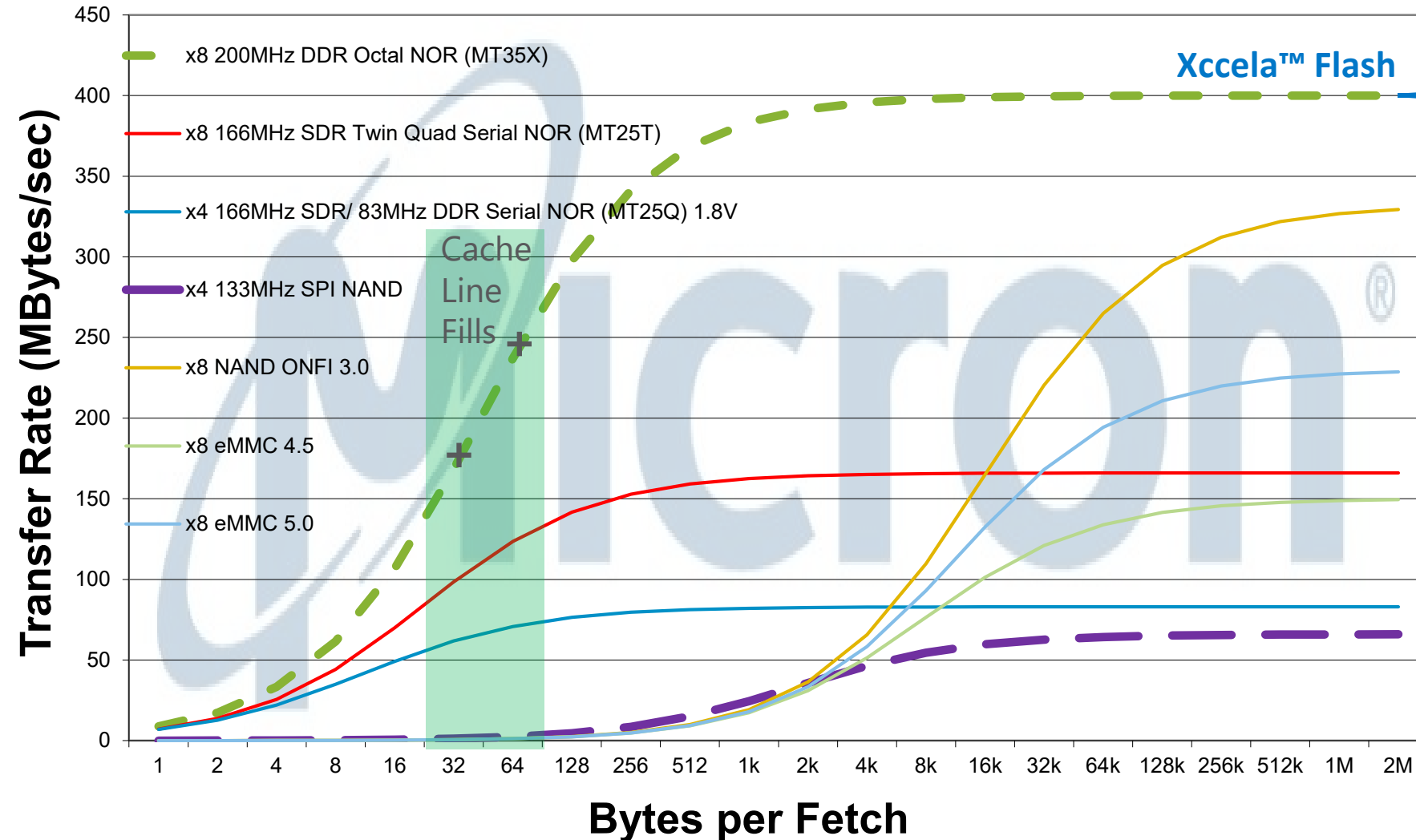
# The Evolution of SPI



|                        | SPI   | Dual-SPI | Quad-SPI               | Twin Quad              | Octal                   |
|------------------------|-------|----------|------------------------|------------------------|-------------------------|
| <b># of Signals</b>    | 6     | 6        | 6                      | 10-12                  | 11                      |
| <b>Clock (max)</b>     | 75MHz | 75MHz    | 180MHz SDR (90MHz DDR) | 180MHz SDR (90MHz DDR) | 166MHz SDR (200MHz DDR) |
| <b>Bandwidth (max)</b> | 9MB/s | 18MB/s   | 90MB/s                 | 180MB/s                | 400MB/s                 |

# Micron Read Performance Comparisons

## NOR and NAND Performance Comparisons Random Read Access Performance vs. Data Size



### Xccela™ Flash Highest Performance

BOOT or Read time at 400MB/s

|              |         |         |         |
|--------------|---------|---------|---------|
| Bit density  | 512Mb   | 1Gb     | 2Gb     |
| Byte density | 64MB    | 128MB   | 256MB   |
| Time to read | .16 sec | .32 sec | .64 sec |

Graphic image read @2Bytes (65K colors)

|              |         |         |
|--------------|---------|---------|
| Pixel Size   | 1K x 1K | 4K x 4K |
| Byte density | 2MB     | 34MB    |
| Time to read | 5.2ms   | 88ms    |



# Packaging

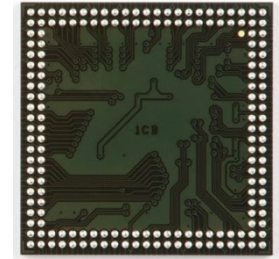
**MCP (Multi Chip Package),  
PoP (Package on Package)**

---

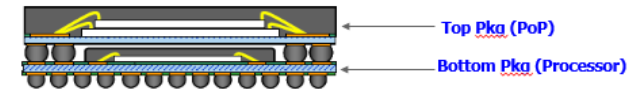
# What is an e.MCP/e.PoP?

e.MCP is a Multi Chip Package including e.MMC and LPDDR<sub>x</sub>

e.PoP is an e.MCP in a PoP (Package on Package) design



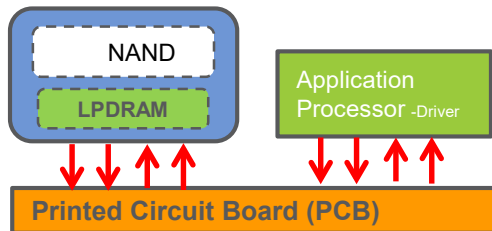
PoP Package



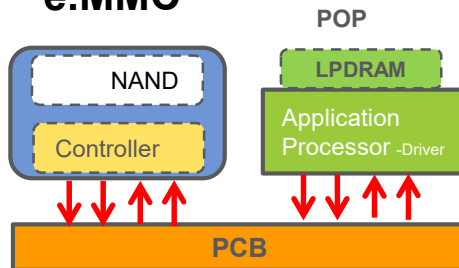
- Benefits include...

- Board space savings through vertical stacking of several memory chips
- Minimize bill of materials for simplified manufacturing and cost savings
- High density, low power consumption, shortest interconnections possible
- Accelerated time to market through rapid integration of modules

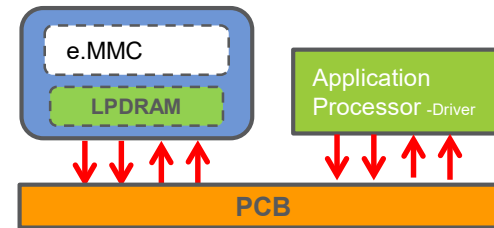
## NAND MCP



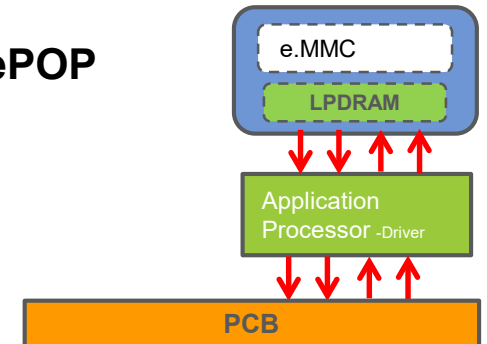
## e.MMC



## eMCP



## ePOP



# Link to Micron's DRAM Power Calculators

<https://www.micron.com/support/tools-and-utilities/power-calc>

## System Power Calculators

Whether it is calculating battery life for a portable application, planning cooling for a desktop, or determining the power supply for a server, an accurate power budget for the memory is essential.

That's why we've created the Micron System-Power Calculator for all of our SDRAM devices. A system designer can use these models to accurately approximate the power requirements of SDRAM in a system environment, as well as experiment with various memory access schemes to determine the impact on power consumption.

These tools provide an easy method for estimating the memory power requirements needed in making important system architecture and design decisions. With an accurate estimation of power consumption, the system designer can quickly handle complex system trade-offs to optimize the system performance.

For more detailed information on system-power calculations, see the following technical notes:

- [DDR TN-46-03](#)
- [DDR2 TN-47-04](#)
- [DDR3 TN-41-01](#)
- [RLDRAM II TN-49-04](#)
- [Mobile LPDRAM TN-46-12](#)
- [Mobile LPDDR2 TN-42-01](#) (Restricted Access)

## Download Calculator to Excel

- [SDRAM System-Power Calculator\\*](#)
- [DDR SDRAM System-Power Calculator\\*](#)
- [DDR2 SDRAM System-Power Calculator\\*](#)
- [DDR3 SDRAM System-Power Calculator\\*](#)
- [DDR4 SDRAM System-Power Calculator\\*](#)
- [RLDRAM II Power Calculator\\*](#)
- [RLDRAM 3 Power Calculator\\*](#)
- [Mobile LPDDR2 System-Power Calculator\\*](#) (Restricted Access)
- [TN-52-01: LPDDR3 System Power Calculator\\*](#) (Restricted Access)
- [TN-53-01: LPDDR4 System Power Calculator\\*](#) (Restricted Access)
- [TN-53-07: LPDDR4X System Power Calculator\\*](#) (Restricted Access)

\*This spreadsheet is for estimating purposes only. Any information provided herein is provided "as is" and without warranties of any kind. Micron warrants only that its products comply with micron's specification sheet for the product at the time of delivery; provided that deviations from specifications which do not materially affect form, fit or function of such product in the system and configuration in or for which it is initially installed or qualified by customer shall not be deemed to constitute failure to comply with such specifications.

# Link to Micron's DRAM Technical Notes:

- <https://www.micron.com/search-results?searchRequest=%7b%22Filters%22%3a%5b%7b%22QueryToken%22%3a%22doc%22%2c%22UseLogicalOr%22%3afalse%2c%22Ids%22%3a%5b%225538556e-d3e6-4d71-95ce-3986f06fbf34%22%5d%7d%5d%7d>

Advanced Filters

Showing 16 results. Sort by: Relevance Show: 20

Products

Memory [Reset all](#)

DRAM

- DDR SDRAM (3)
- DDR2 SDRAM (4)
- DDR3 SDRAM (16)
- DDR4 SDRAM (2)
- LPDRAM (2)
- RLDRAM Memory (1)
- SDRAM (2)

DRAM Modules

Multichip Packages

NAND Flash

NOR Flash

Content Types

All Content Types (A-Z) [Reset all](#)

- Technical Notes (16)

DDR3 SDRAM Technical Notes Clear all

**TN-00-01: Moisture Sensitivity of Plastic Packages**  
Technical Notes (PDF) - 10.14.2018  
This technical note describes shipping procedures for preventing memory devices from absorbing moisture and recommendations for baking devices exposed to excessive moisture.  
[Download](#)

**TN-04-54: High-Speed DRAM Controller Design**  
Technical Notes (PDF) - 4.15.2008  
This technical note identifies and discusses five key areas of DRAM controller design.  
[Download](#)

**TN-00-19: Thinning Considerations for Wafer Products**  
Technical Notes (PDF) - 10.14.2009  
This technical note provides information on optimal wafer-thinning processes to meet specific customer requirements.  
[Download](#)

**User's Manual: New Features of DDR3 SDRAM**  
Technical Notes (PDF) - 2.25.2014  
This manual is intended for users who design application systems using DDR3 SDRAM manufactured by Elpida.  
[Download](#)

**TN-41-14: DDR3 SDRAM 1.35V-to-1.5V Compatibility**  
Technical Notes (PDF) - 10.16.2012  
Clarifies the voltage backward compatibility statement for 1.35V DDR3L and DDR3Lm devices  
[Download](#)

**TN-41-04: DDR3 Dynamic On-Die Termination**  
Technical Notes (PDF) - 3.13.2008  
With DDR3, dynamic ODT provides systems with increased flexibility to optimize termination values for different loading conditions  
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# Links to Micron's NOR Flash Technical Notes:

<https://www.micron.com/search-results?searchRequest=%7b%22Filters%22%3a%5b%7b%22QueryToken%22%3a%22doc%22%2c%22UseLogicalOr%22%3afalse%2c%22Ids%22%3a%5b%22538556e-d3e6-4d71-95ce-3986f06fbf34%22%5d%7d%5d%7d>

**Advanced Filters**

**Products** [^](#)

Memory [Reset all](#)

**NOR Flash** [^](#)

Parallel NOR Flash (2)

Serial NOR Flash (2)

Xcelera Flash (3)

**Solutions** [v](#)

**Content Types** [^](#)

All Content Types (A-Z) [Reset all](#)

Technical Notes (3)

Showing 3 results.

Sort by: Relevance Show: 20

Xcelera Flash  Technical Notes  [Clear all](#)

**TN-12-30: NOR Flash Cycling Endurance and Data Retention**  
Technical Notes (PDF) - 11.14.2017

This technical note defines the industry standards for this testing, Micron's NOR Flash testing methodology, and the two key metrics used to measure NOR device failure: cycling endurance and data retention.

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**TN-25-08: Maximize SPI NOR, Xcelera™ Flash and Quad SPI NAND Memory Design Flexibility with a Single Package**  
Technical Notes (PDF) - 9.16.2018

This technical note discusses how a single 24-ball BGA package (6 x 8 mm) can support a variety of flash products, enabling designers to offer a range of densities, features and performance levels simply by replacing the installed flas

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**TN-12-30: NOR Flash Cycling Endurance and Data Retention (Japanese)**  
Technical Notes (PDF) - 7.8.2015

This technical note defines the industry standards for this testing, Micron's NOR Flash testing methodology, and the two key metrics used to measure NOR device failure: cycling endurance and data retention.

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# Link to Micron's e.MMC Technical Notes:

- <https://www.micron.com/search-results?searchRequest=%7b%22Filters%22%3a%5b%7b%22QueryToken%22%3a%22doc%22%2c%22UseLogicalOr%22%3afalse%2c%22lds%22%3a%5b%22538556e-d3e6-4d71-95ce-3986f06fbf34%22%5d%7d%5d%7d>

Showing 24 results. Sort by:  Show:

**Advanced Filters**

**Products**

Memory

**Managed NAND**

eMMC (24)

**Multichip Packages**

**Solutions**

**Content Types**

All Content Types (A-Z)

Technical Notes (24)

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**TN-FC-62: e.MMC PCB Design Guide 5.1**  
🔒 Technical Notes - 10.10.2018  
This technical note is a guide for PCB designers using Micron e.MMC 5.1 devices.  
[Download](#)

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**TN-FC-41: e.MMC Factory Reset Preferred Erase Method**  
🔒 Technical Notes - 9.23.2015  
This technical note explains the difference between the two options and the guidelines to properly sanitize (purge) the sensitive data stored physically on Micron memory.  
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**TN-FC-32: e.MMC Device Health Report**  
🔒 Technical Notes - 12.16.2014  
This technical note describes the Device Health Report procedure for Micron Mobile e.MMC memory devices.  
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**TN-29-84: e.MCP v5.1 Command Queue QSR Polling Solution**  
🔒 Technical Notes - 8.30.2018  
This technical note describes how to check for and correct the QSR timeout condition.  
[Download](#)

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**TN-FC-54: Refresh Features for Micron e.MMC Automotive 5.0 Devices**  
🔒 Technical Notes - 3.14.2018  
This technical note describes additional data refresh features available in Micron e.MMC automotive 5.0 devices built with Micron firmware.  
[Download](#)

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**TN-FC-35: e.MMC PCB Design Guide**  
🔒 Technical Notes - 1.22.2019  
This technical note is a guide for PCB designers using Micron e.MMC devices.  
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# Link to Micron's SSD Technical Notes:

- <https://www.micron.com/search-results?searchRequest=%7b%22Filters%22%3a%5b%7b%22QueryToken%22%3a%22doc%22%2c%22UseLogicalOr%22%3afalse%2c%22Ids%22%3a%5b%22538556e-d3e6-4d71-95ce-3986f06fbf34%22%5d%7d%5d%7d>

The screenshot shows a search results page on the Micron website. On the left is a sidebar with 'Advanced Filters' and categories like 'Products', 'Storage', 'Solid State Drives', 'Solutions', and 'Content Types'. The main content area shows 4 results, sorted by 'Relevance'. The results are:

- TN-FD-47: 2100AI/AT PCIe Schematics Reference Design**  
Technical Notes - 5.16.2019  
This document provides system design guidelines for PCI NVMe™ SSDs belonging to Micron's 2100AT/2100AI product family.  
Download
- TN-FD-45: Host Memory Buffer in 2100AI/AT SSDs**  
Technical Notes - 11.14.2018  
This technical note describes NVMe's Host Memory Buffer, and how it is implemented in the Micron 2100AI/AT SSD product family with details on how Linux OS manages this feature to support customer system integration.  
Download
- TN-FD-15: P320h/P420m SSD Performance Optimization and Testing**  
Technical Notes (PDF) - 4.7.2014  
This technical note describes how to optimize and test the performance of the Micron P320h and P420m SSDs.  
Download
- TN-FD-46: NVMe Linux Enablement**  
Technical Notes - 5.20.2019  
This technical note describes Linux support for NVMe in regards to using Host Memory Buffer.  
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